



Study of the onset of multiplication in proton irradiated LGADs

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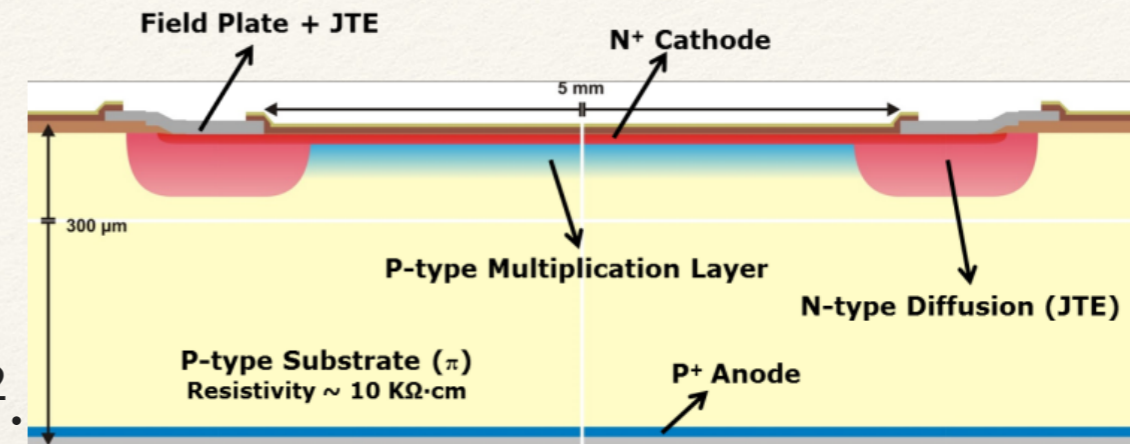
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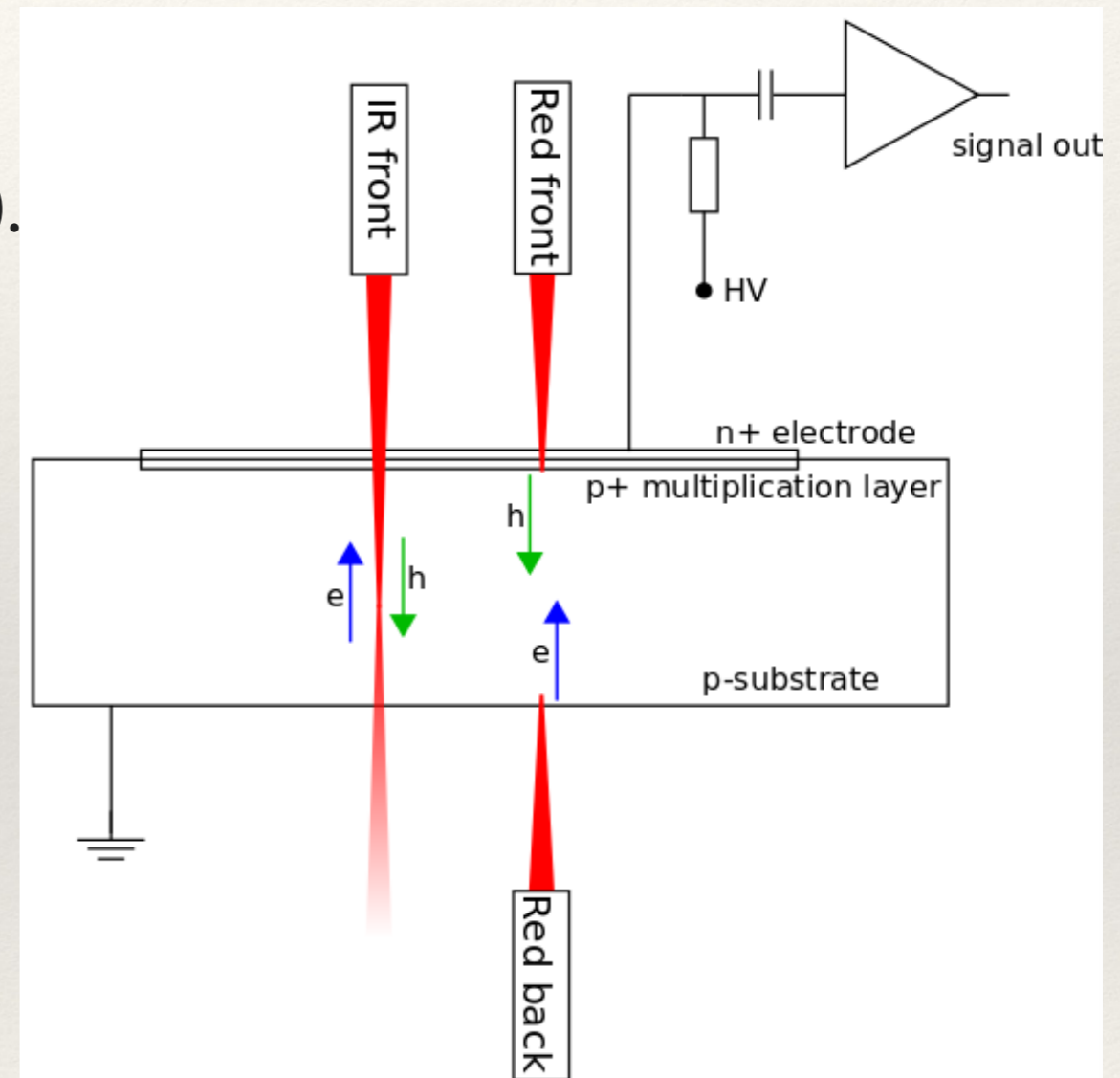
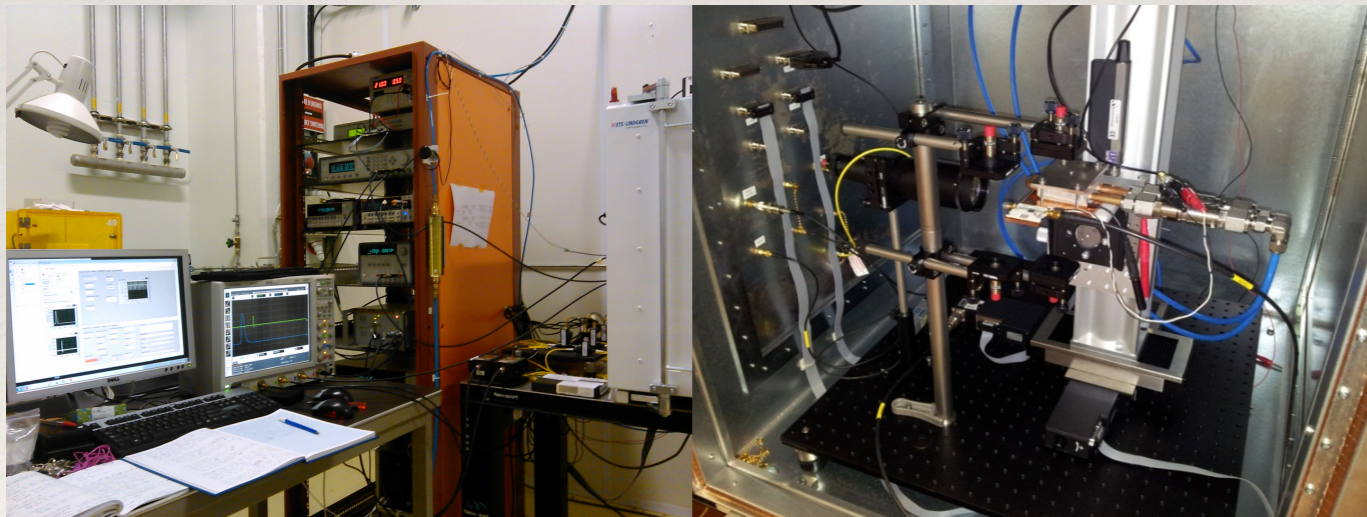
Continuation of the work presented in Torino

S. Otero Ugobono, *TCT Measurements and Analyses of Proton Irradiated LGADs*, 28th RD50 Workshop 

- ❖ LGADs from Run 7859.
 - ❖ Wafers 1 and 2.
 - ❖ Multiplication layer dose: $1.8 \times 10^{13} \text{ cm}^{-2}$.
 - ❖ Wafers 3 and 4.
 - ❖ Multiplication layer dose: $2.0 \times 10^{13} \text{ cm}^{-2}$.
- ❖ Irradiation performed at the PS facility with 24-GeV/c protons.
- ❖ Fluences:
 - ❖ $10^{12} \text{ 1 MeV } n_{\text{eq}} / \text{cm}^2$
 - ❖ $10^{13} \text{ 1 MeV } n_{\text{eq}} / \text{cm}^2$
 - ❖ $10^{14} \text{ 1 MeV } n_{\text{eq}} / \text{cm}^2$
 - ❖ $10^{15} \text{ 1 MeV } n_{\text{eq}} / \text{cm}^2$
- ❖ Annealing: 80 min at 60°C.

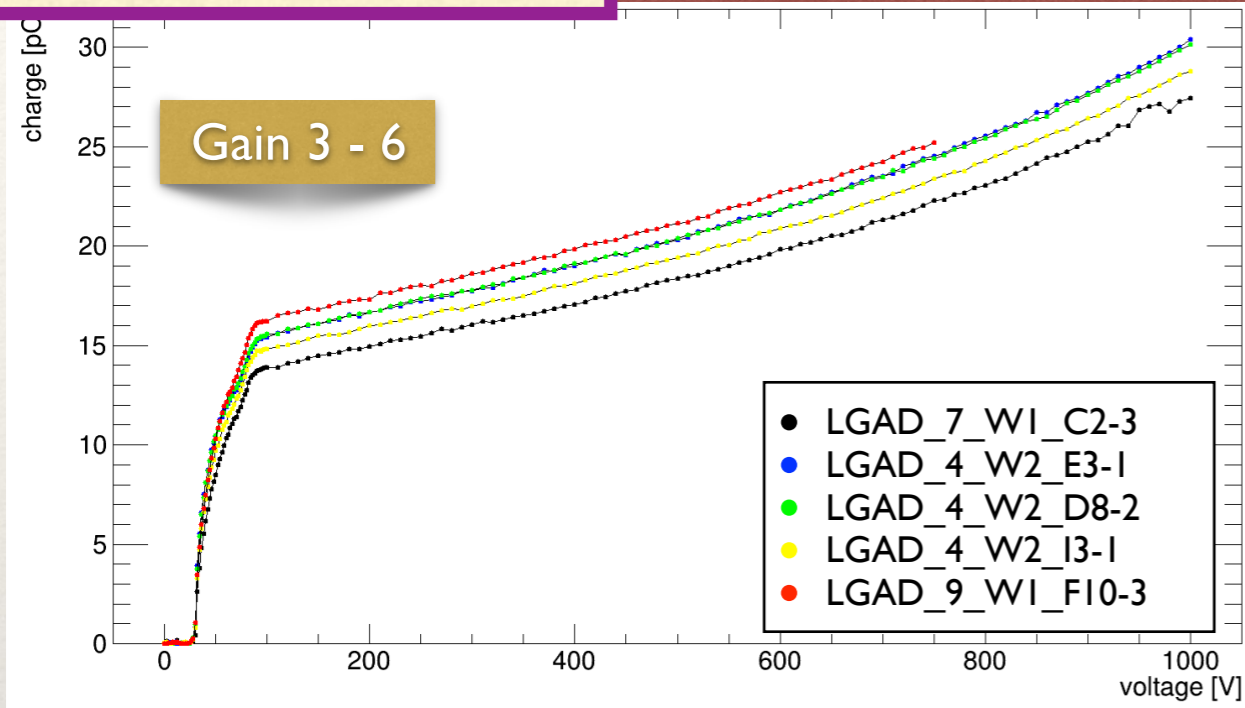


- ❖ Picosecond-pulsed LASER (200 ps).
 - ❖ Red front and back (660 nm, 47.4 μW).
 - ❖ IR front and back (1064 nm, 29.5 μW).

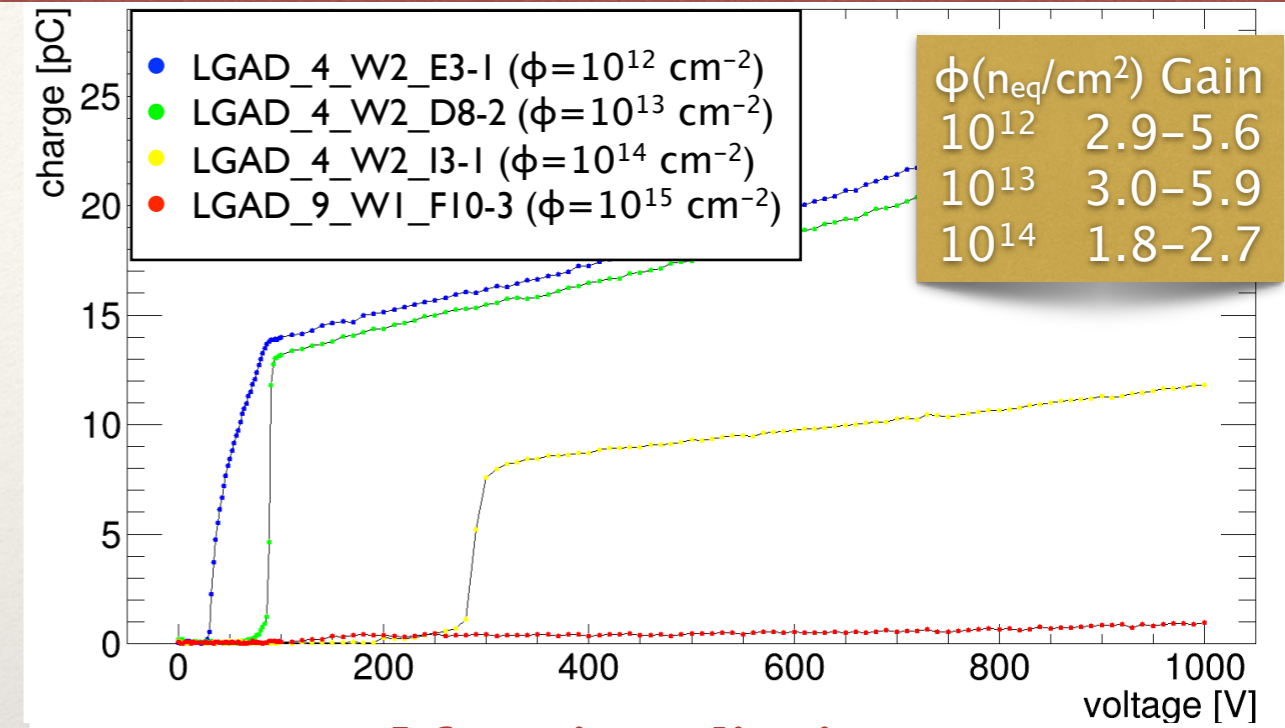


Mult. layer $1.8 \times 10^{13} \text{ cm}^{-2}$

LGAD - TCT - Red front @ -20°C

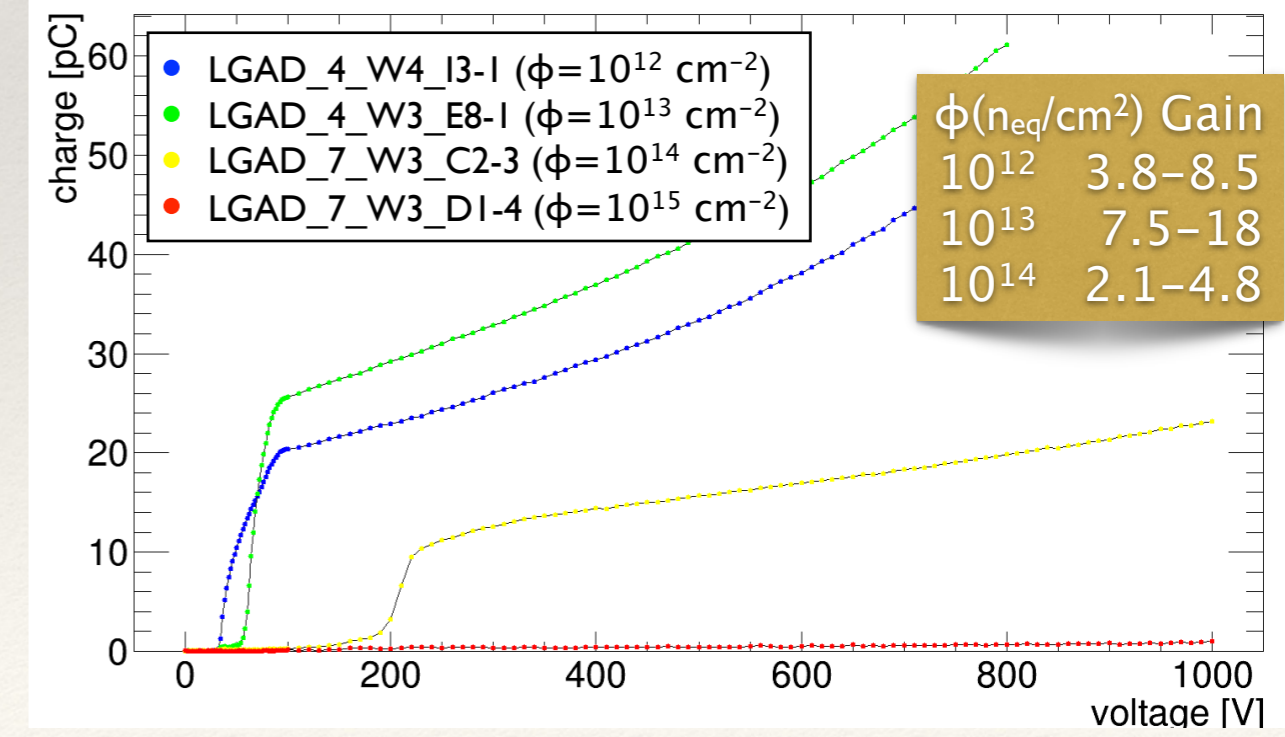
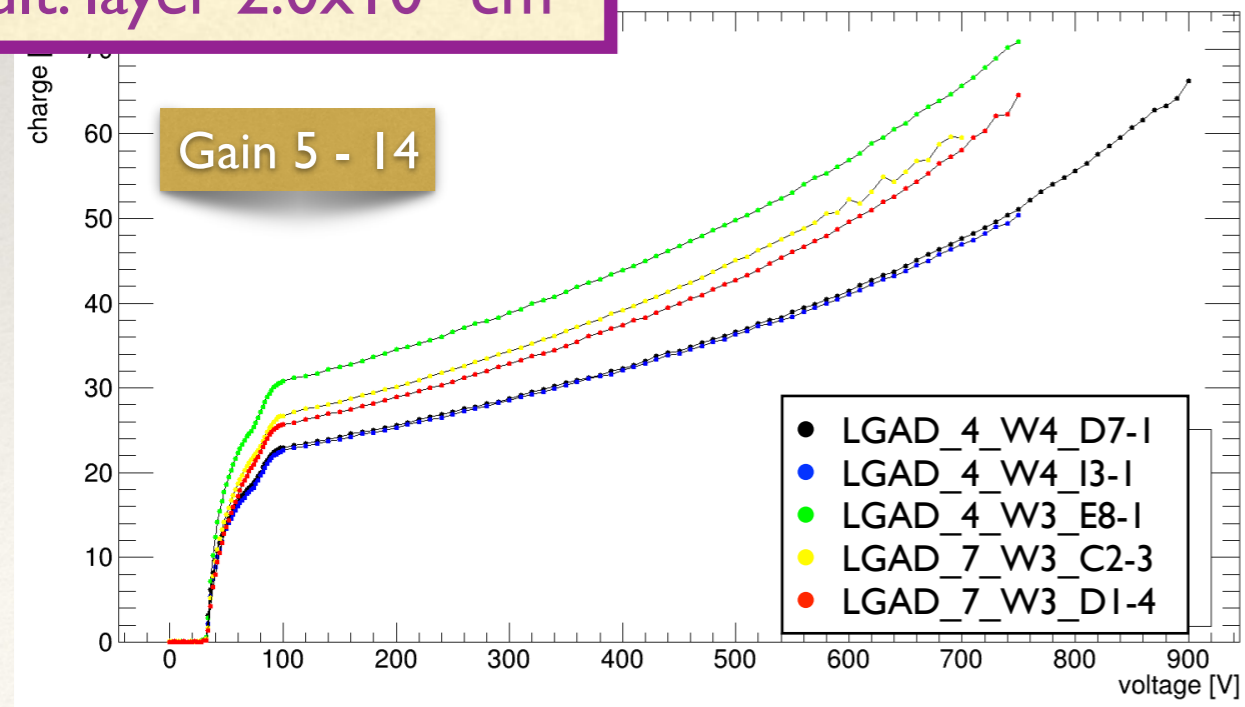


Before irradiation



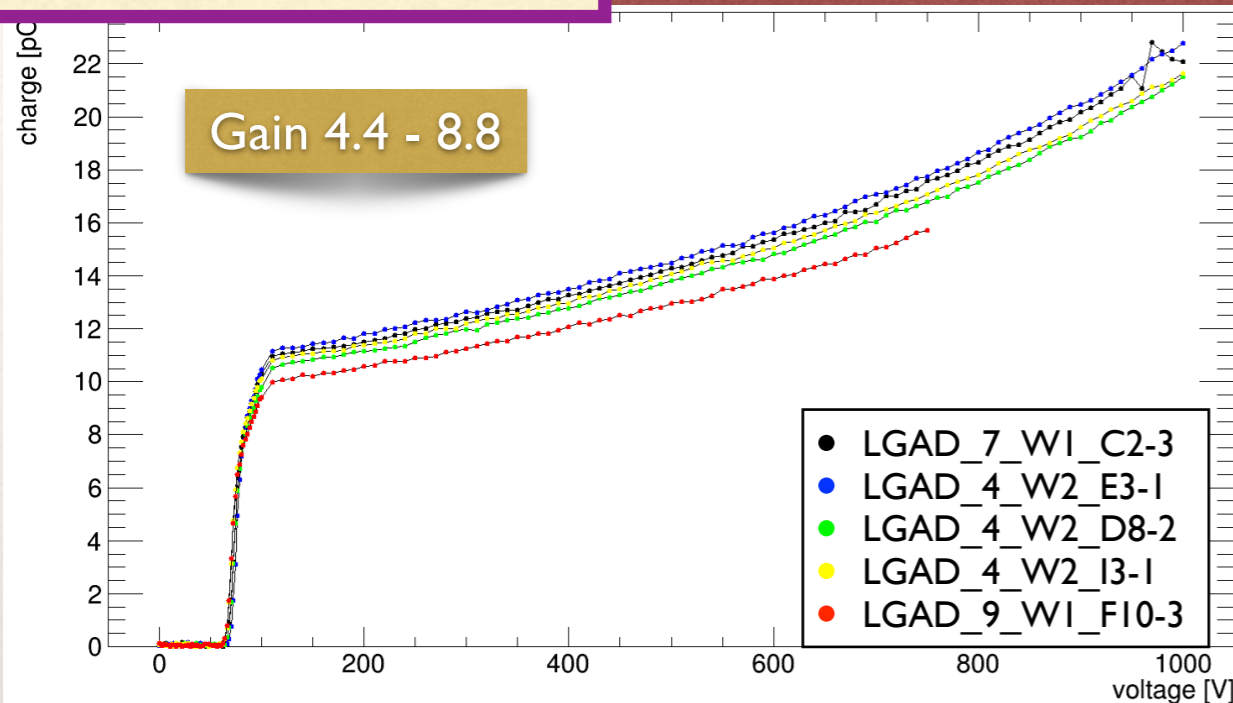
After irradiation

Mult. layer $2.0 \times 10^{13} \text{ cm}^{-2}$

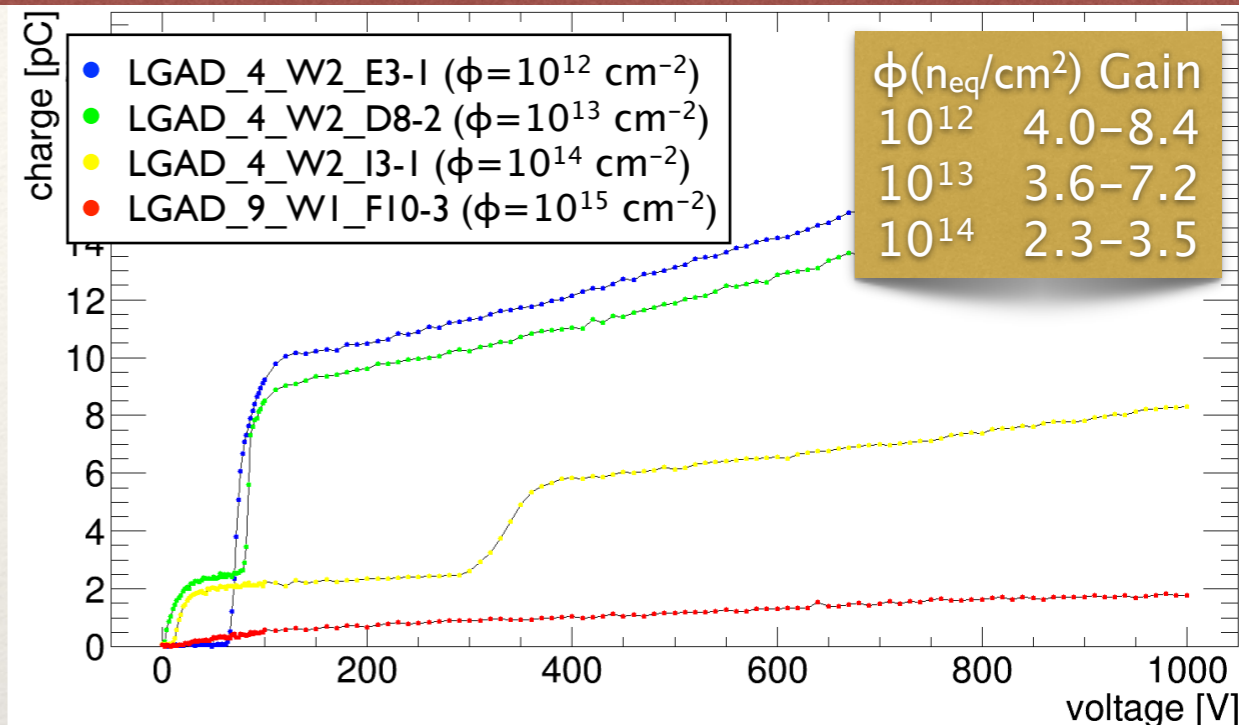


Mult. layer $1.8 \times 10^{13} \text{ cm}^{-2}$

LGAD - TCT - Red back @ -20°C

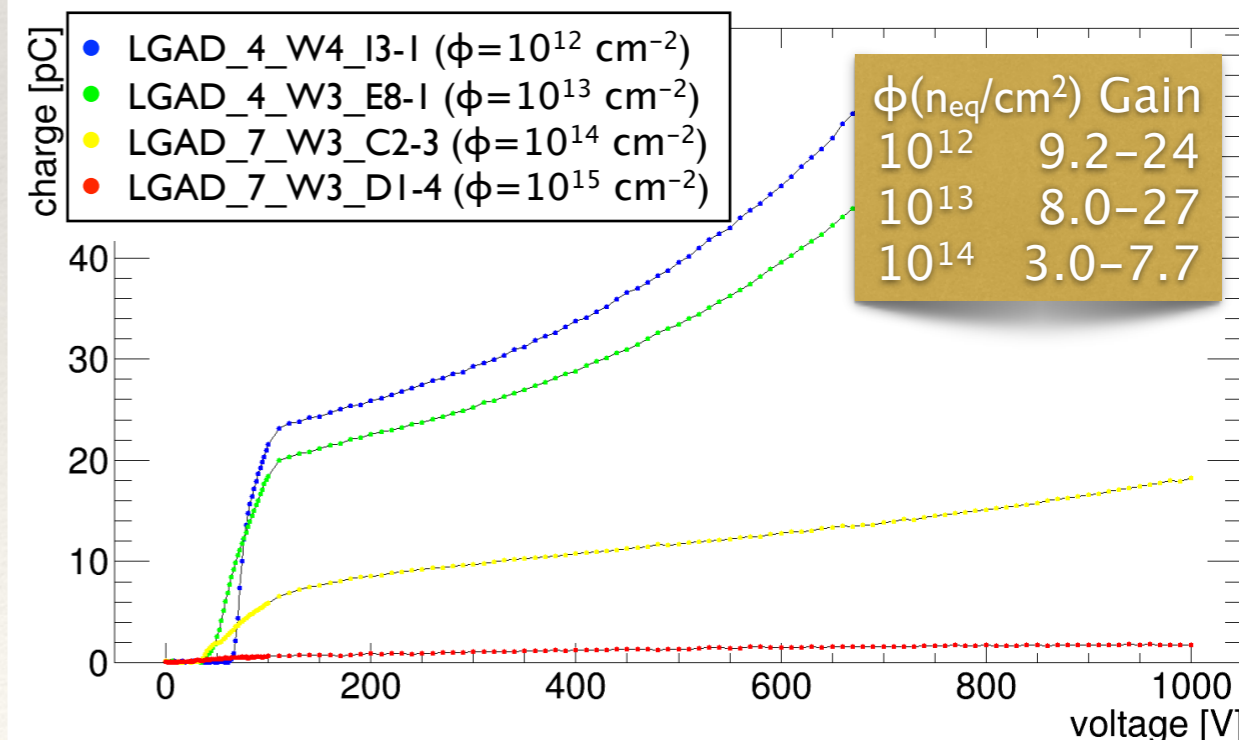
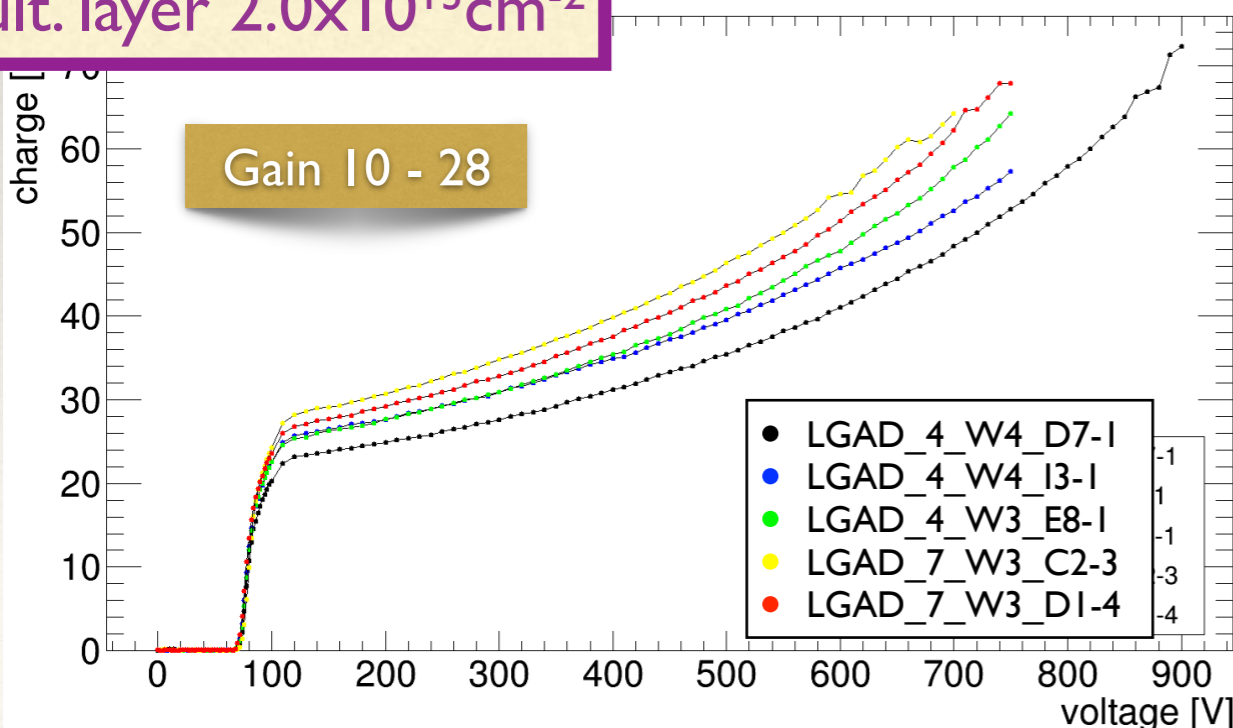


Before irradiation

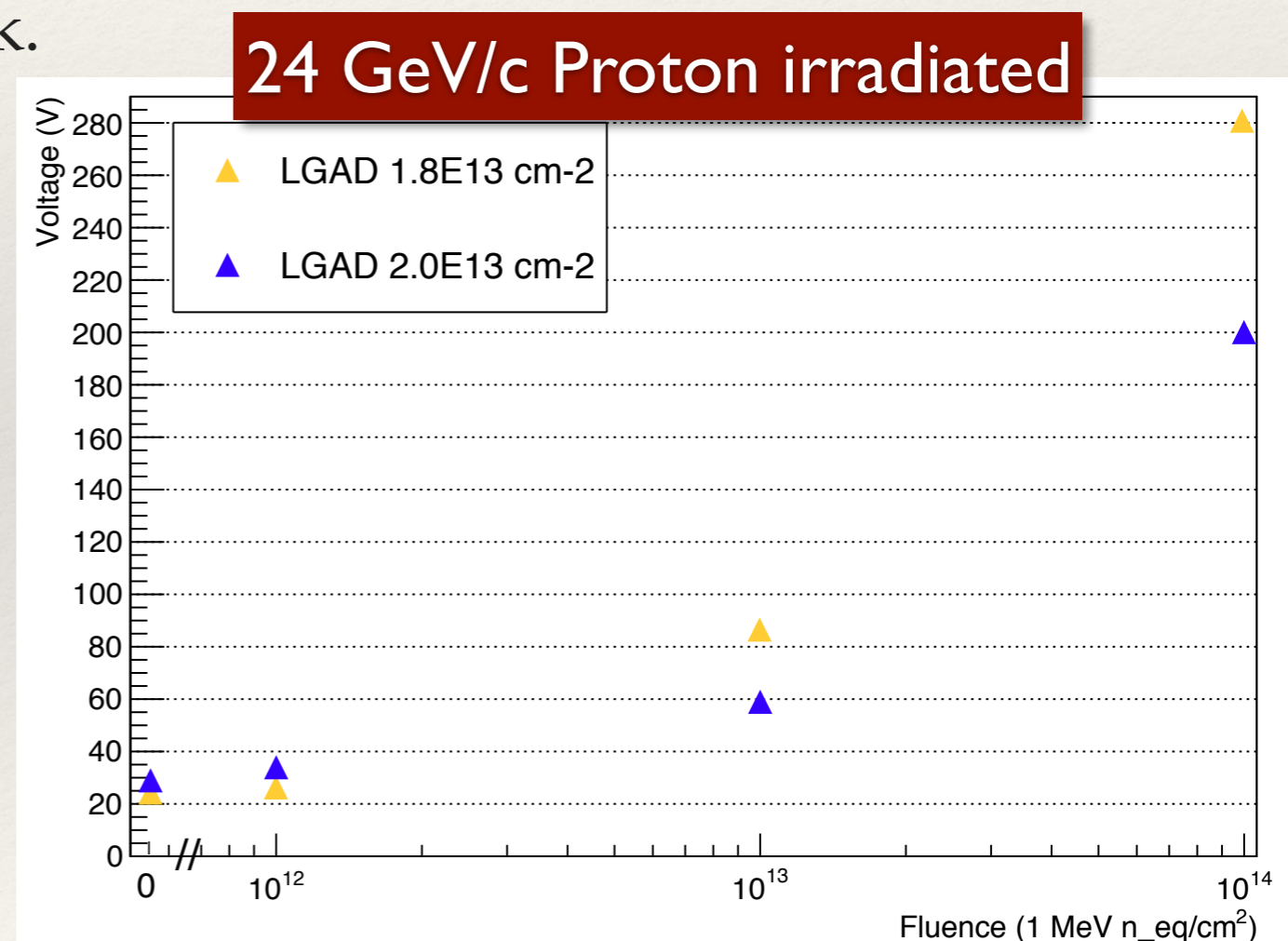
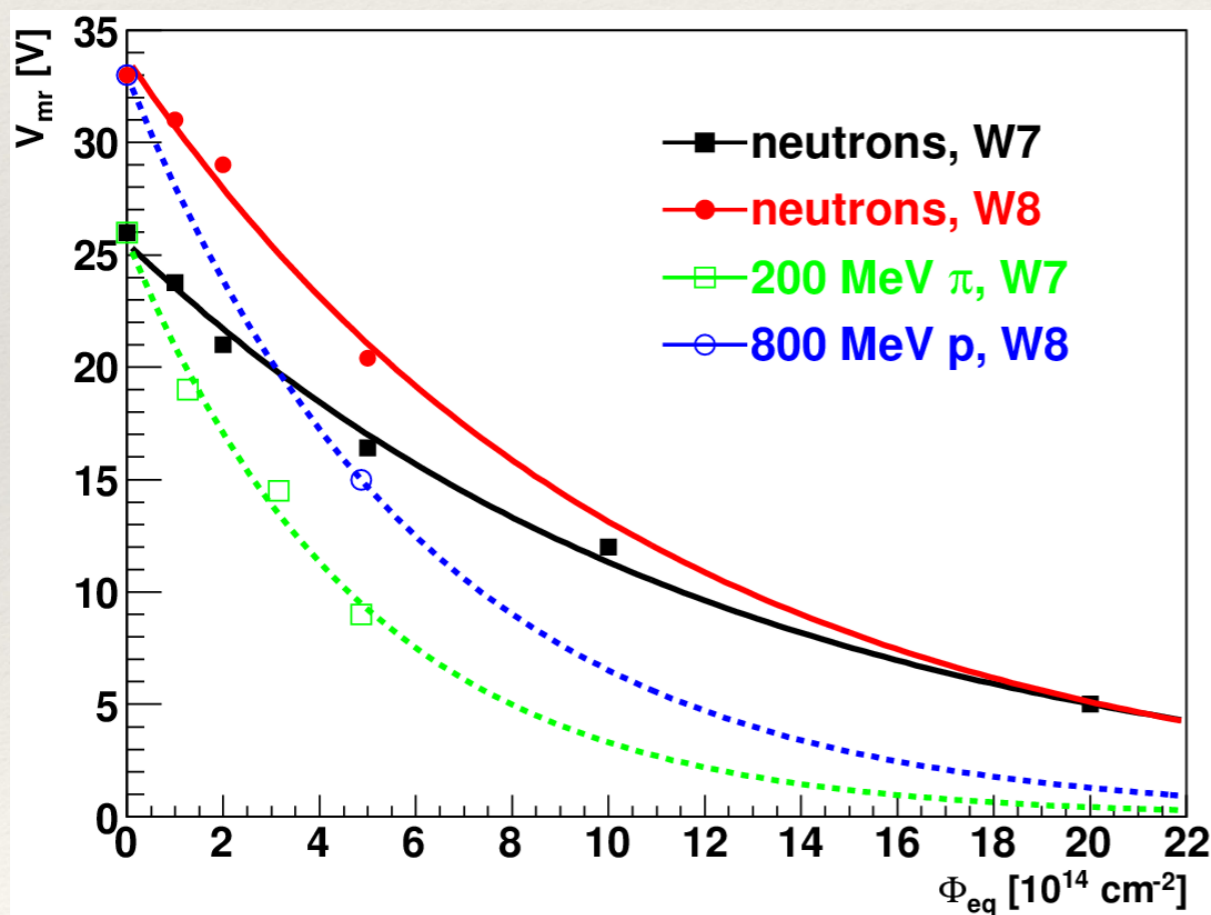


After irradiation

Mult. layer $2.0 \times 10^{13} \text{ cm}^{-2}$



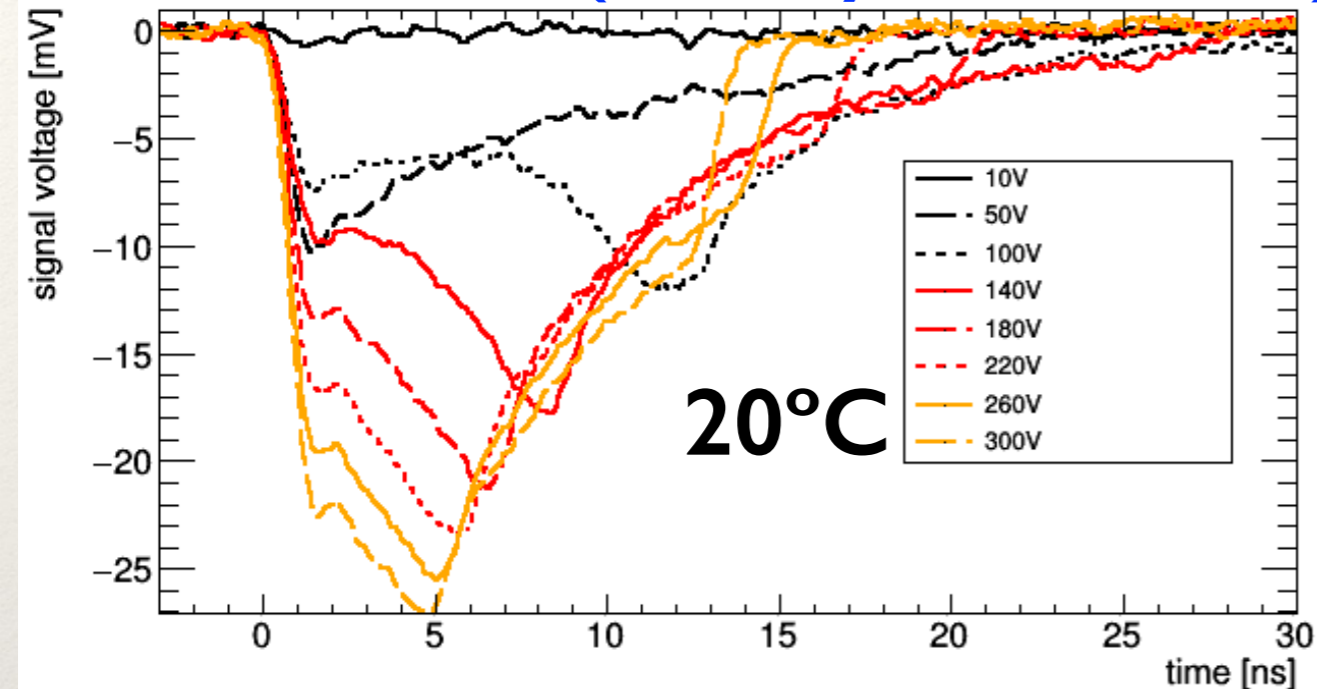
- ❖ According to Gregor's results* (CNM run 6474), the threshold voltage decreases with fluence.
- ❖ The opposite effect was observed in the LGADs from CNM run 7859.
- ❖ Most plausible explanation: double junction effect due to hole trapping.
- ❖ The device is depleted from the back.



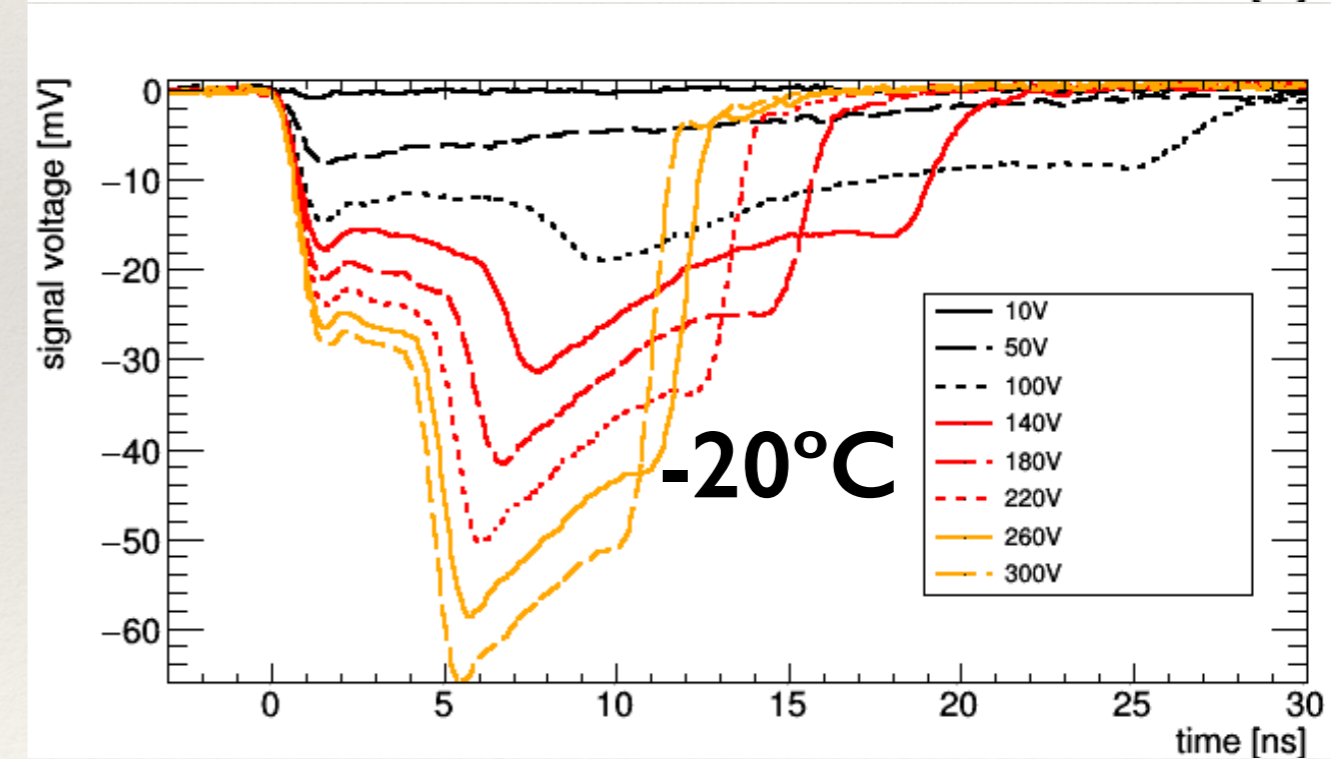
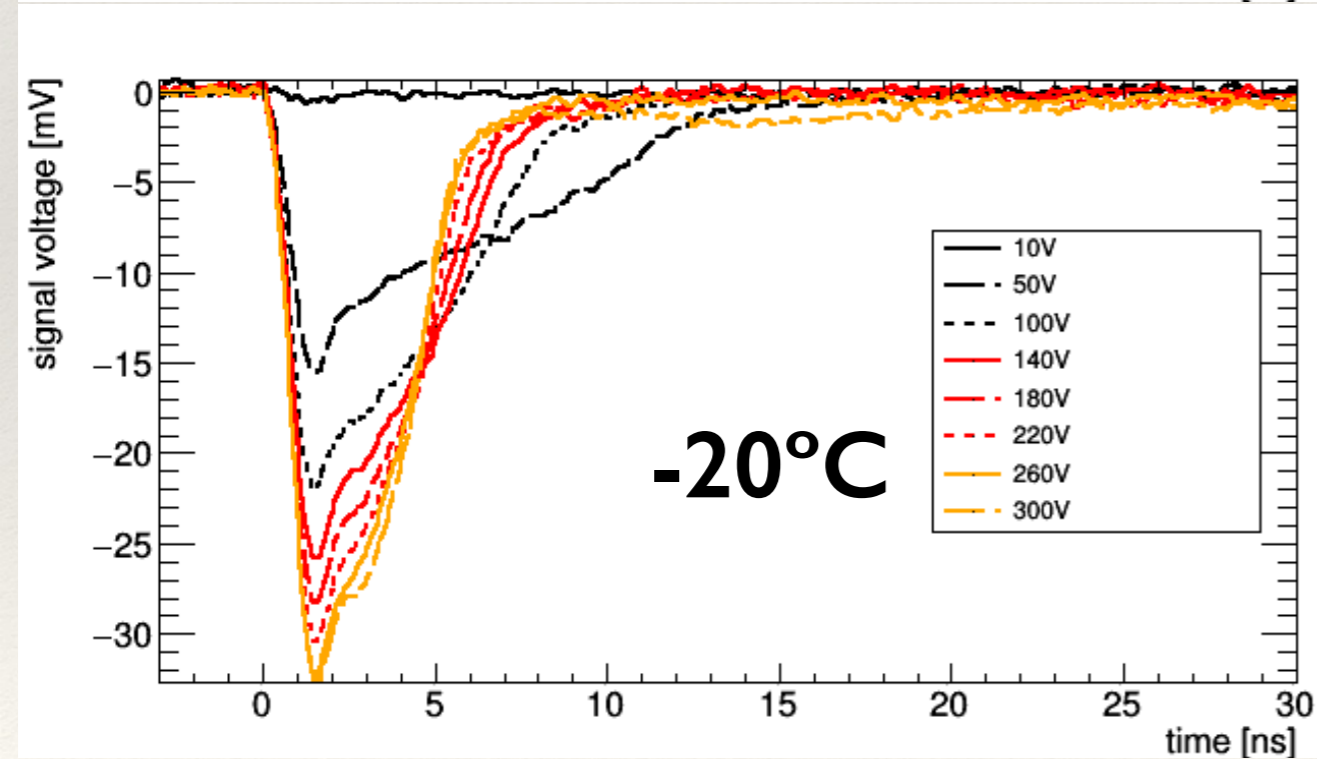
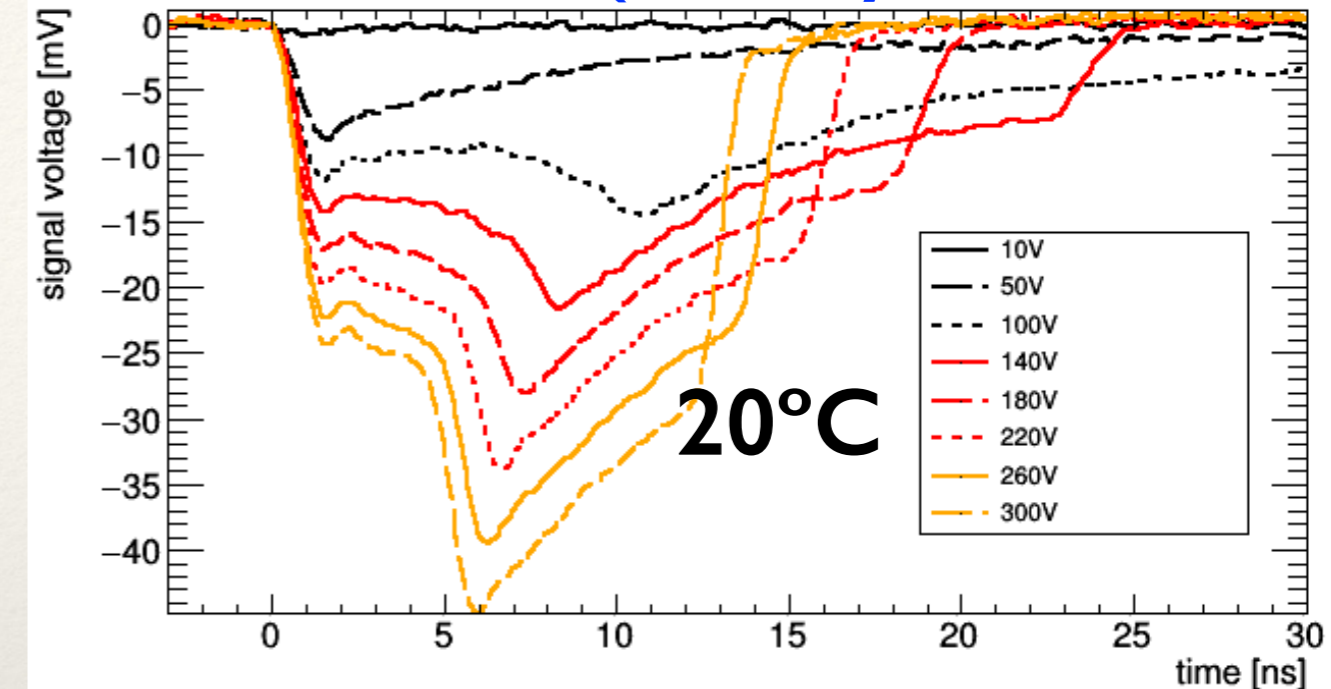
*G. Kramberger et al., *Radiation effects in Low Gain Avalanche Detectors after hadron irradiations*.

- ❖ Before irradiation, there are no deep traps => the depletion region grows from the front (multiplication layer).
- ❖ After irradiation, trapping is significant.
- ❖ Multiplication holes can get trapped and thus change the space charge.
- ❖ Because of the occupation probability of traps, the process is highly dependent on temperature.
 - ❖ The lower the temperature, the longer the charges remain trapped.

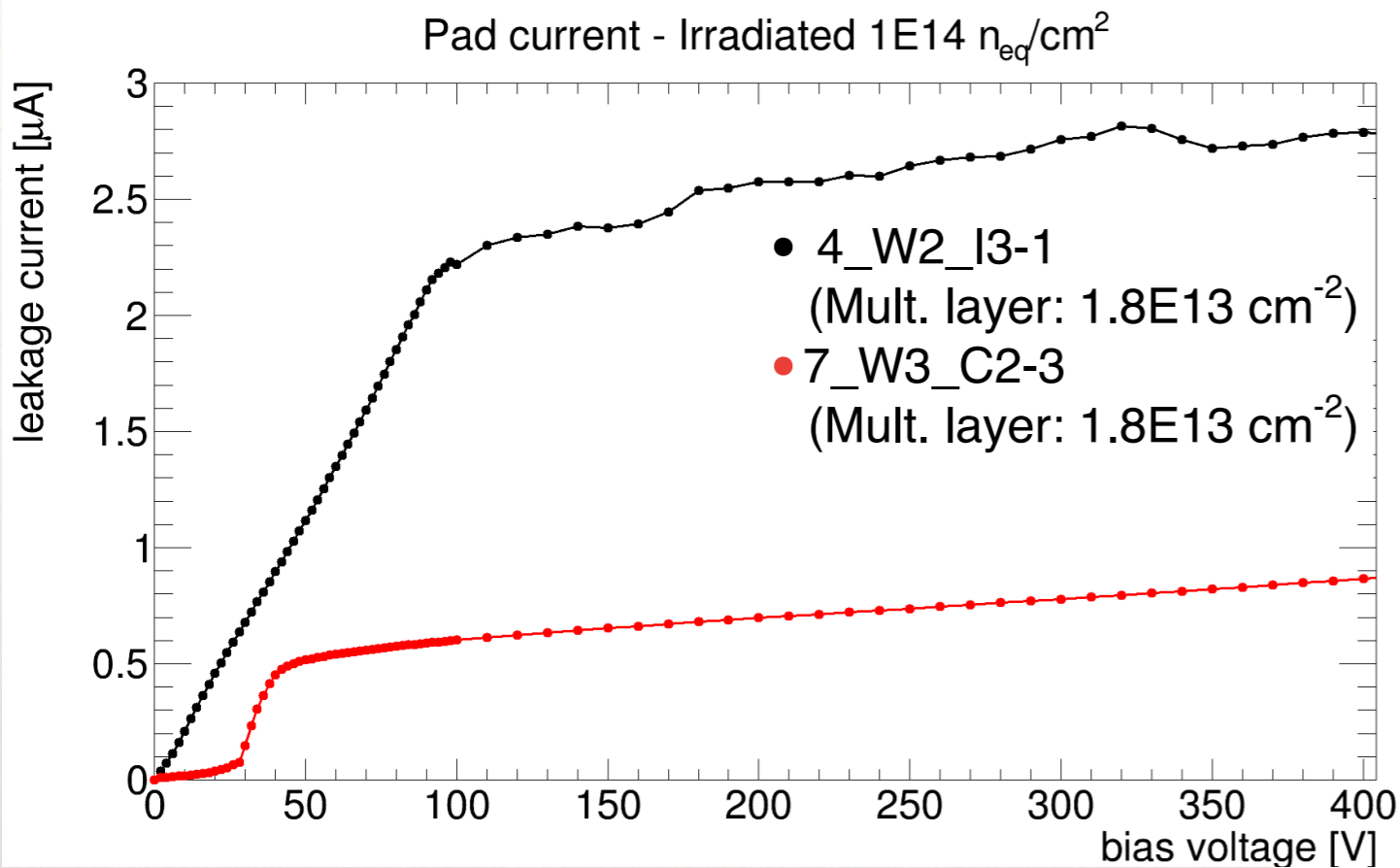
LGAD_4_W2_I3-1 (Mult. layer: 1.8E13 cm²)



LGAD_7_W3_C2-3 (Mult. layer: 2.0E13 cm²)



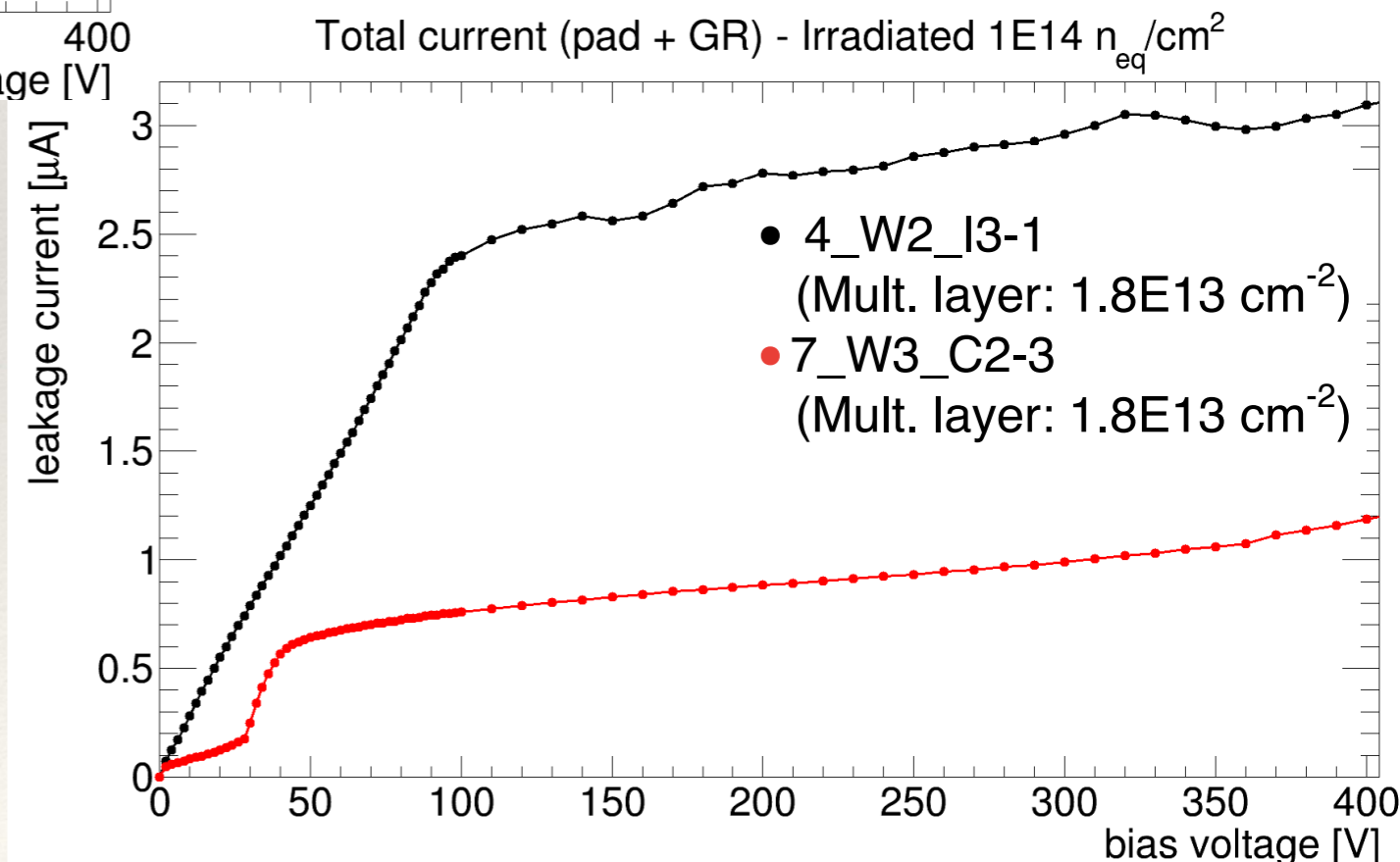
Further analyses of the two LGADs
irradiated up to 10^{14} n_{eq}/cm²



❖ At voltages within the range of the multiplication onset, the current through the Guard Ring is negligible.

❖ Both sensors qualify as *low current devices* according to the classification employed by Gregor.* (Order of nA)

*G. Kramberger, *Effects of irradiation on LGAD devices with high excess current*, 25th RD50 Workshop, CERN, November 2014

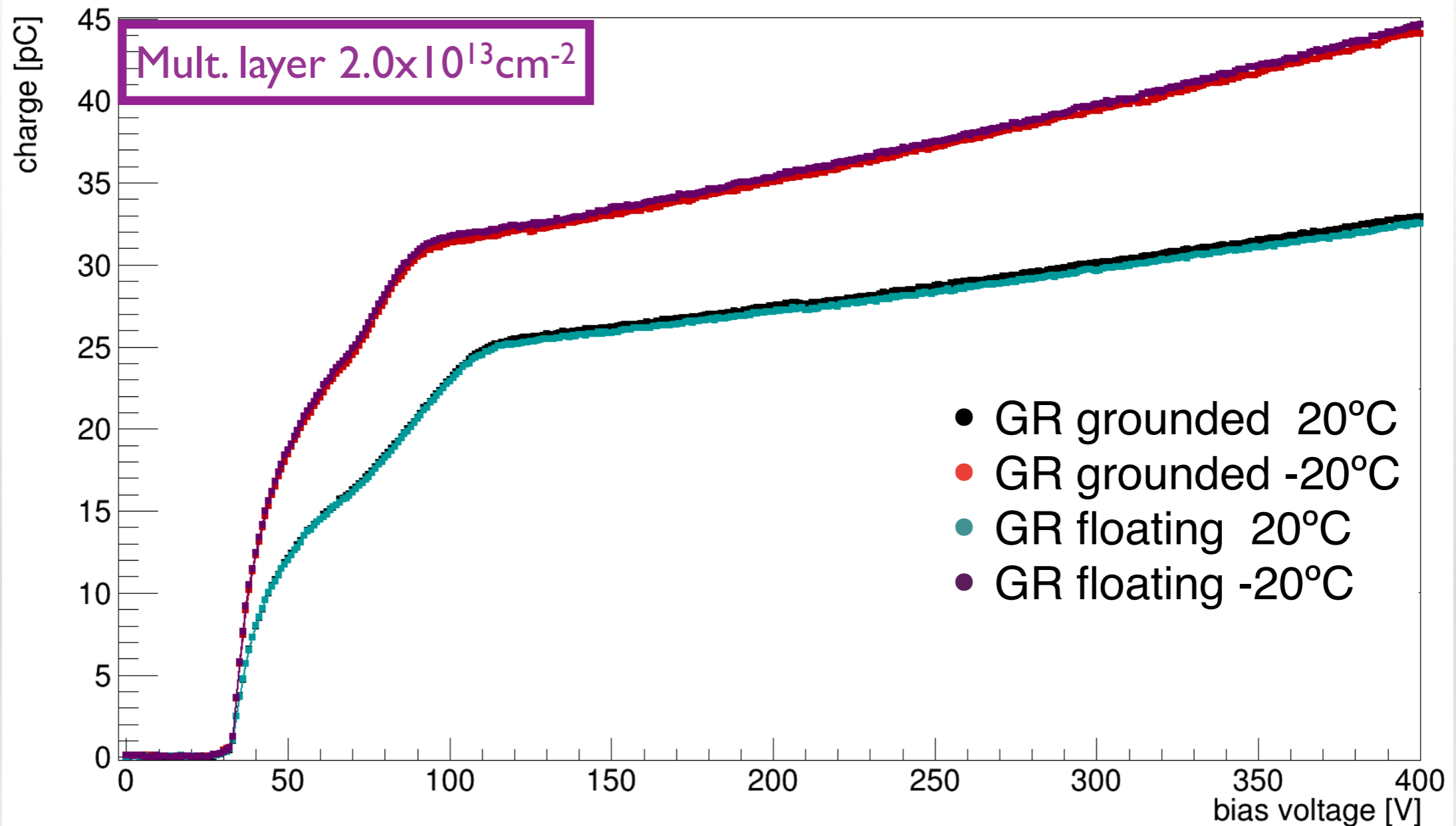


- ❖ TCT voltage scans performed on:
 - ❖ one unirradiated LGAD used as reference (mult. layer $2.0 \times 10^{13} \text{ cm}^{-2}$)
 - ❖ both LGADs irradiated up to $10^{14} n_{\text{eq}} / \text{cm}^2$.

- ❖ Conditions:
 - ❖ Two temperatures: 20°C and -20°C .
 - ❖ To see the effects of temperature on the multiplication onset (double junction effect).
 - ❖ The measurements were performed
 - ❖ with the guard ring (GR) floating (usual procedure)
 - ❖ with the GR connected to ground (to assess any possible differences).
 - ❖ Different bias and read-out schemes were tested.

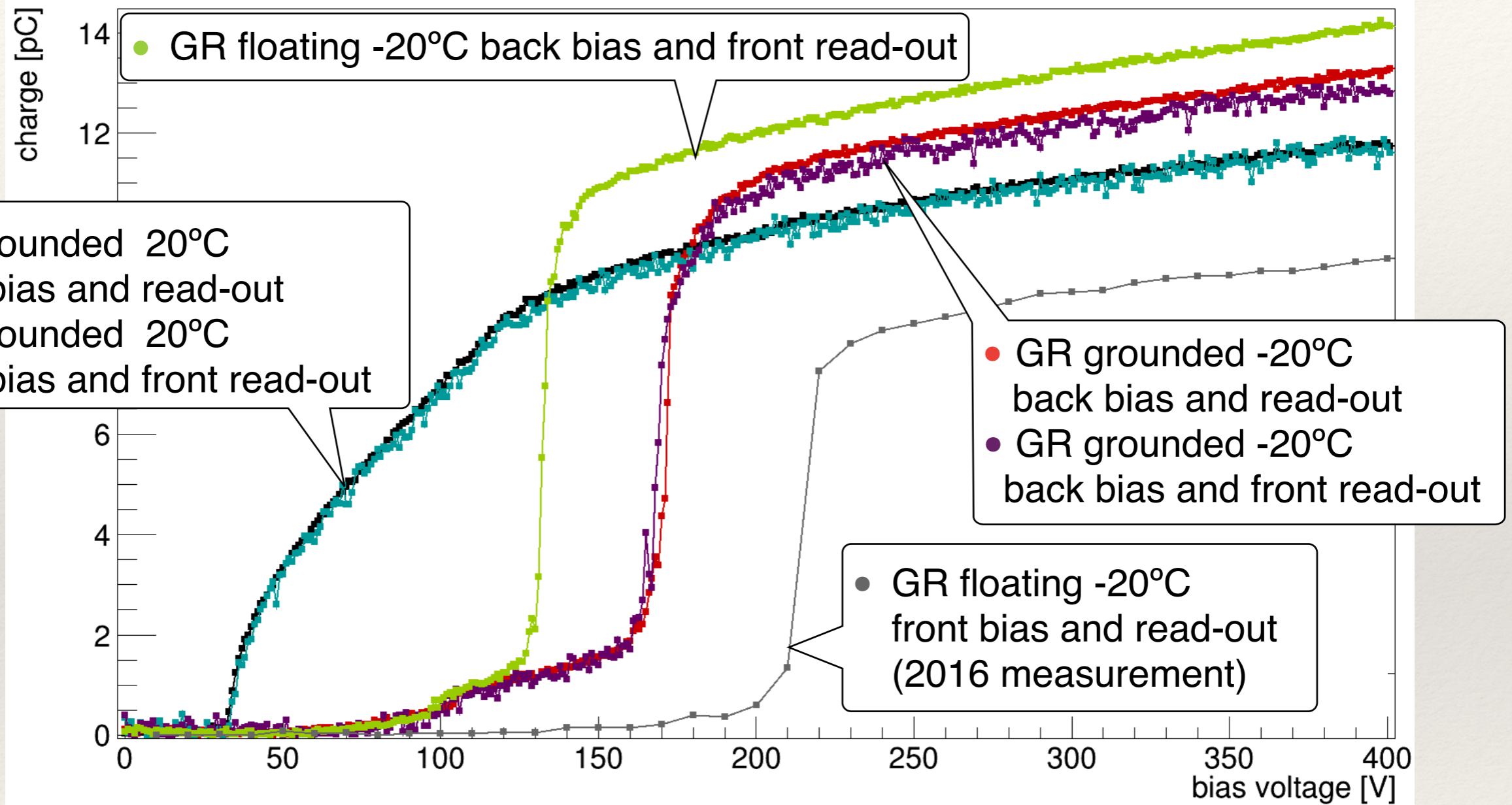
- ❖ The scans were compared to those measured in 2016 and presented at the 28th RD50 Workshop.

Red front TCT - LGAD_7859_W4_D7-1 - Unirradiated - back bias and read-out



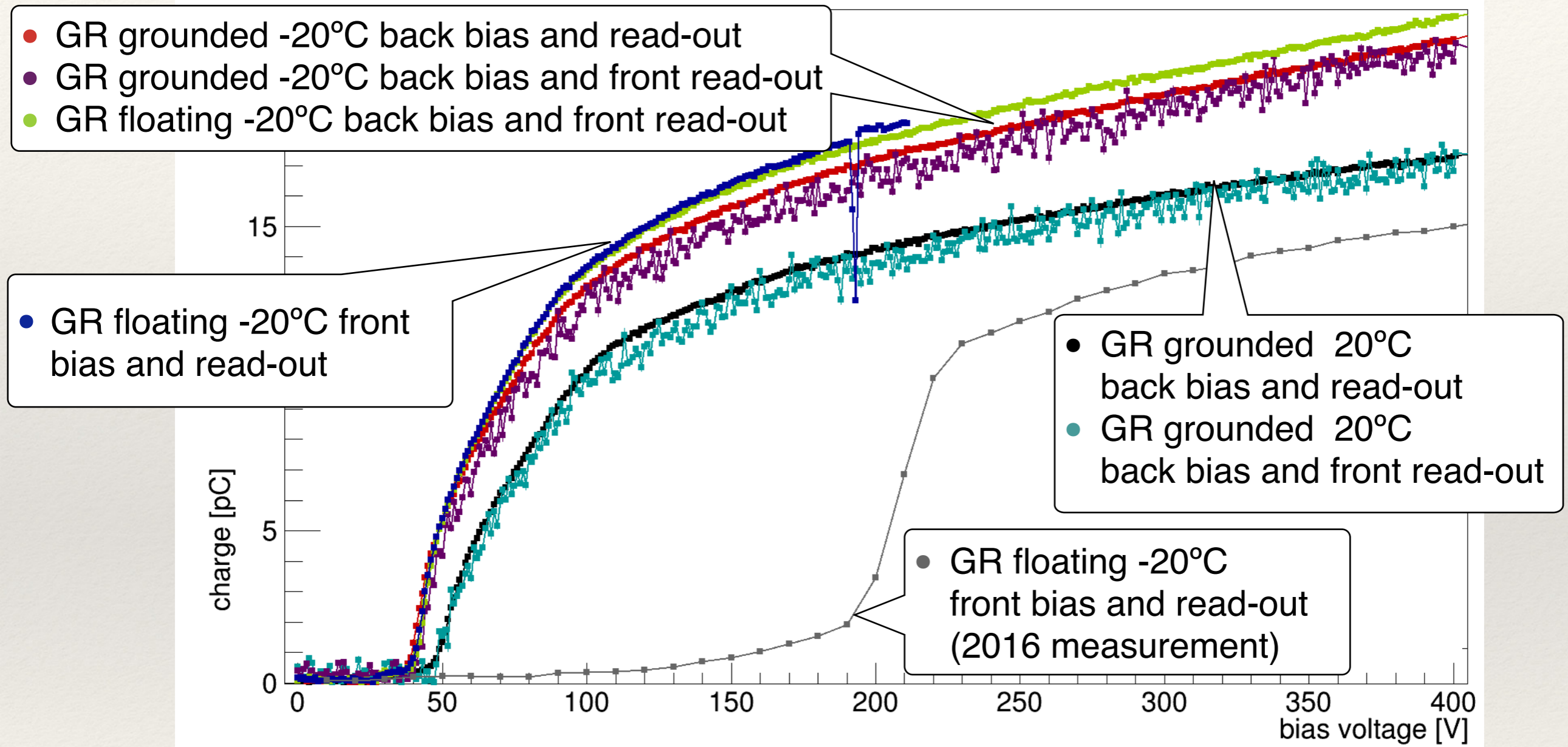
- ❖ The GR connection scheme causes no significant changes.
- ❖ The multiplication onset does not depend on temperature.

Red front TCT - LGAD_7859_4_W2_I3_1 - $1 \text{E}14 \text{ n}_{\text{eq}}/\text{cm}^2$



- ❖ At -20°C the GR shifts the onset of multiplication.
- ❖ The multiplication-onset voltage is higher for lower temperatures.
- ❖ Shift in the multiplication-onset voltage with respect to the value seen in 2016.

Red front TCT - LGAD_7859_7_W3_C2_3 - $1 \text{E}14 \text{ n}_{\text{eq}}/\text{cm}^2$



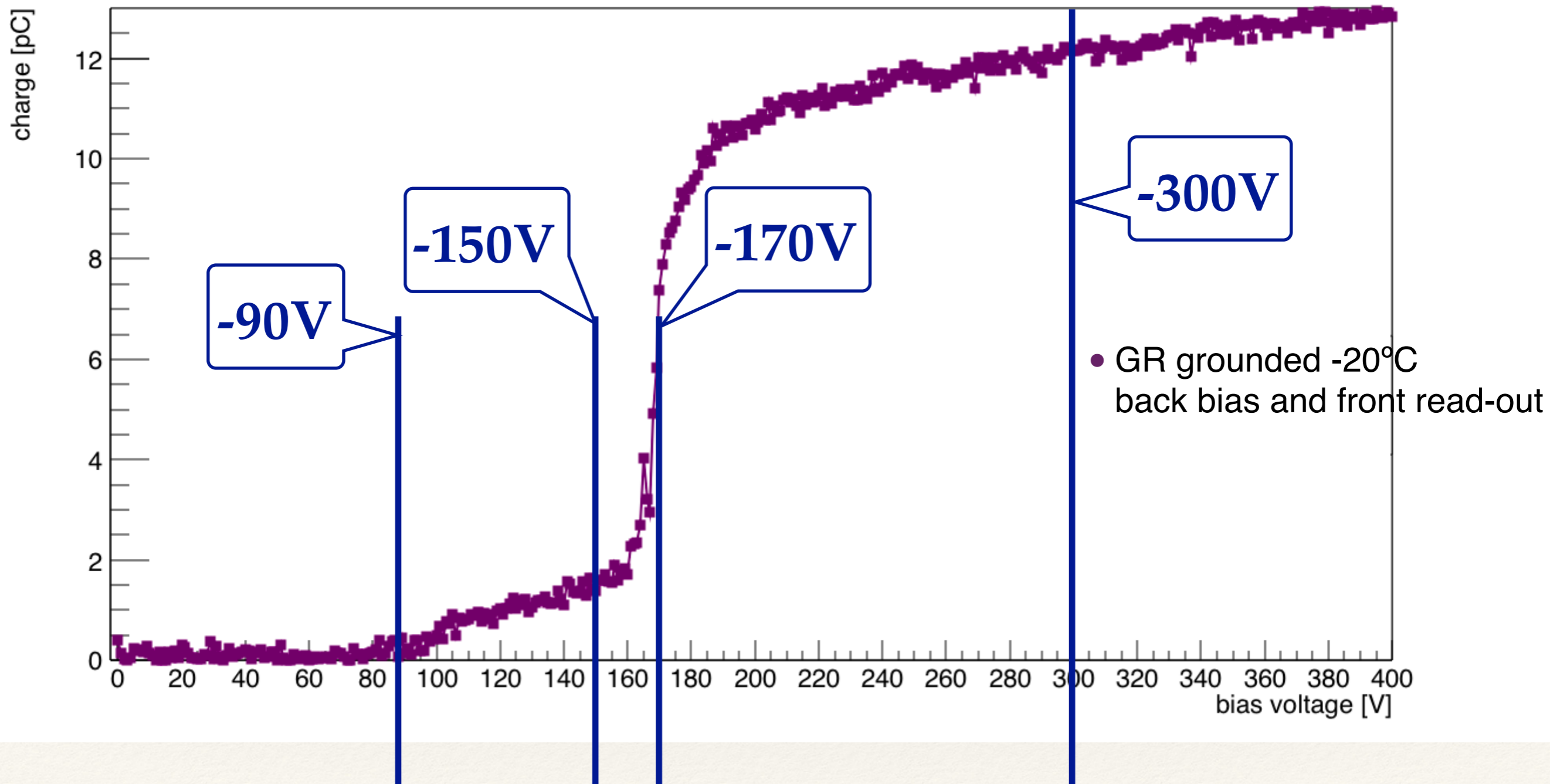
- ❖ Significantly large shift in the multiplication-onset voltage with respect to 2016.
- ❖ The multiplication onset does not change significantly with temperature.
- ❖ The bias and read-out scheme causes no significative changes.

- ❖ In order to better understand the results, eTCT scans were performed on both irradiated samples.
- ❖ The objective is to better comprehend the distribution of the electric field inside the devices.
- ❖ Conditions:
 - ❖ Two temperatures: 20°C and -20°C.
 - ❖ Several voltages (before, during and after the multiplication onset).
 - ❖ All the plots were obtained by integrating the signals up to 0.6 ns.
 - ❖ The edge was not polished (time constraints).

PRELIMINARY
RESULTS

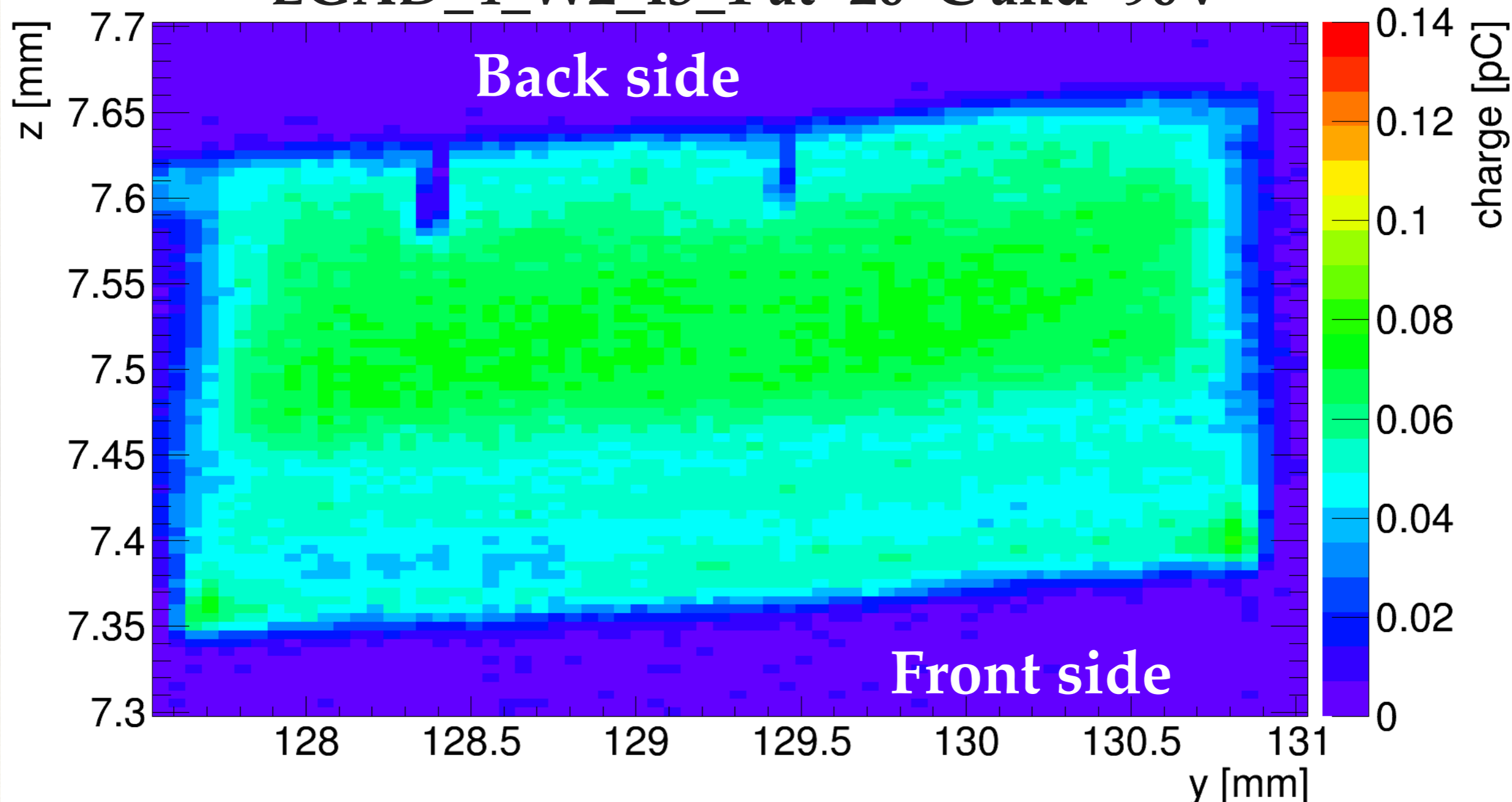
Voltages for eTCT

Red front TCT - LGAD_7859_4_W2_I3_1 - $1 \text{E}14 \text{ n}_{\text{eq}}/\text{cm}^2$



PRELIMINARY

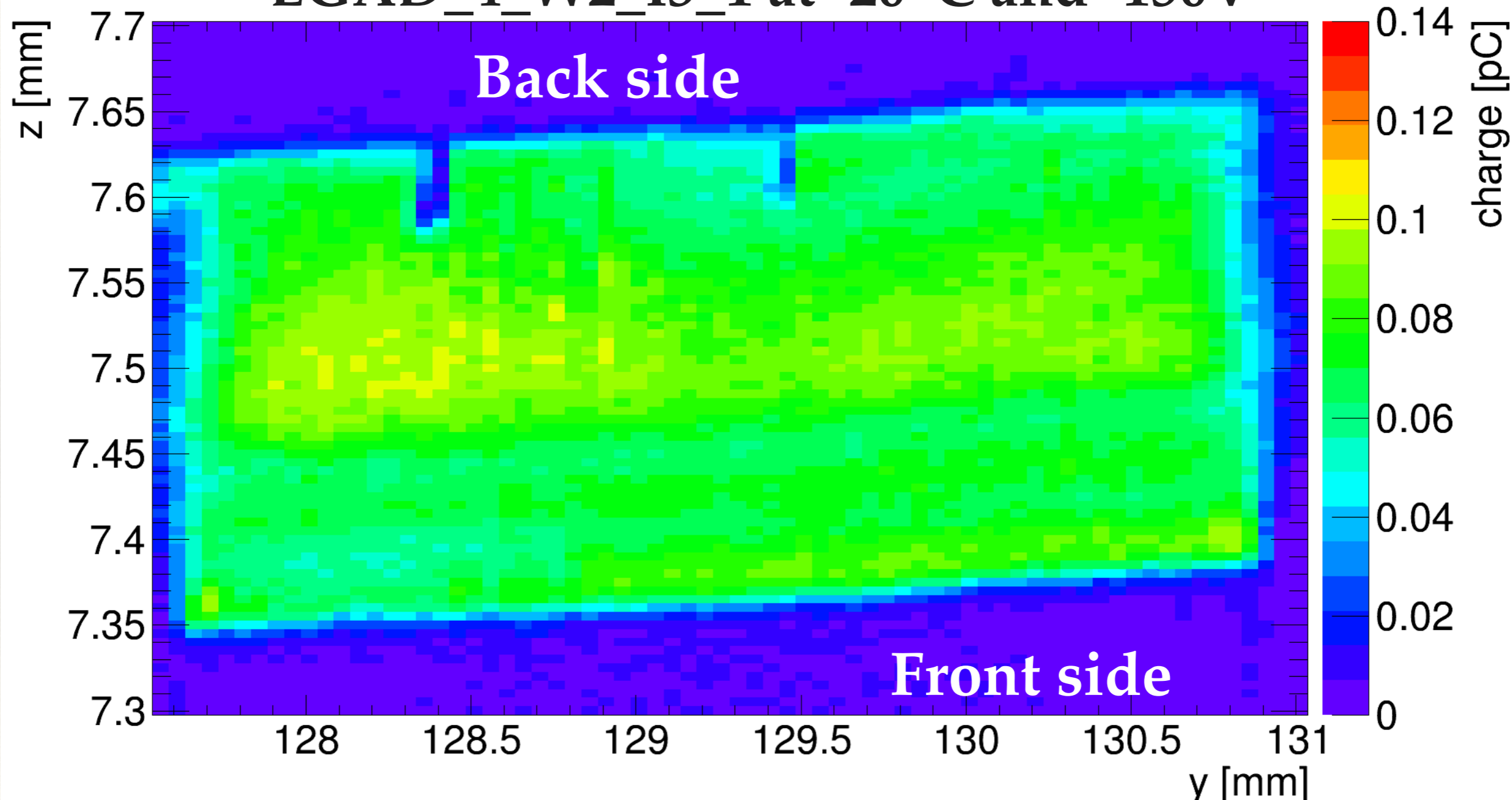
LGAD_4_W2_I3_1 at -20°C and -90V



Integrated charge in 0.6 ns [$Q(0.6 \text{ ns})$]

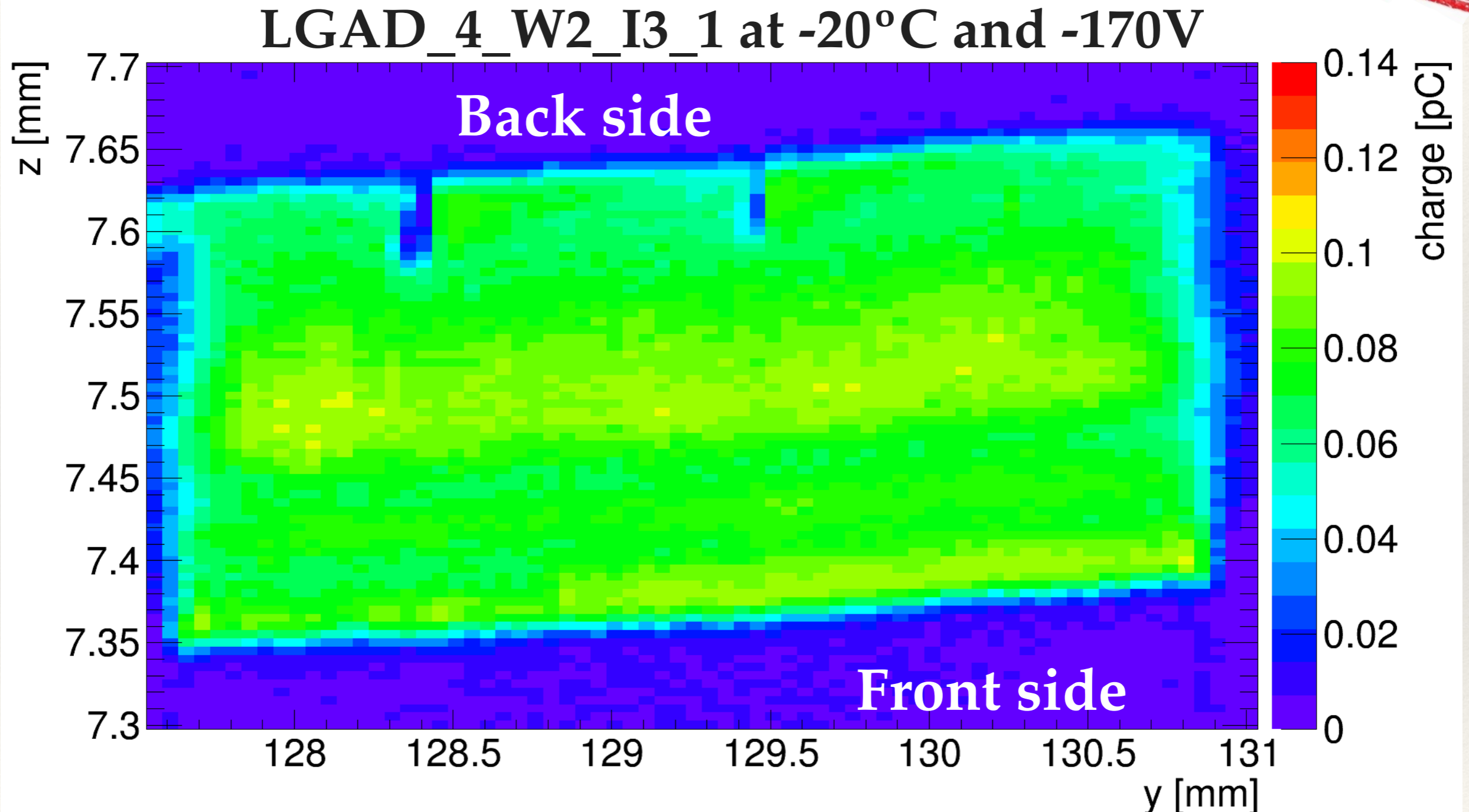
PRELIMINARY

LGAD_4_W2_I3_1 at -20°C and -150V



Integrated charge in 0.6 ns [$Q(0.6 \text{ ns})$]

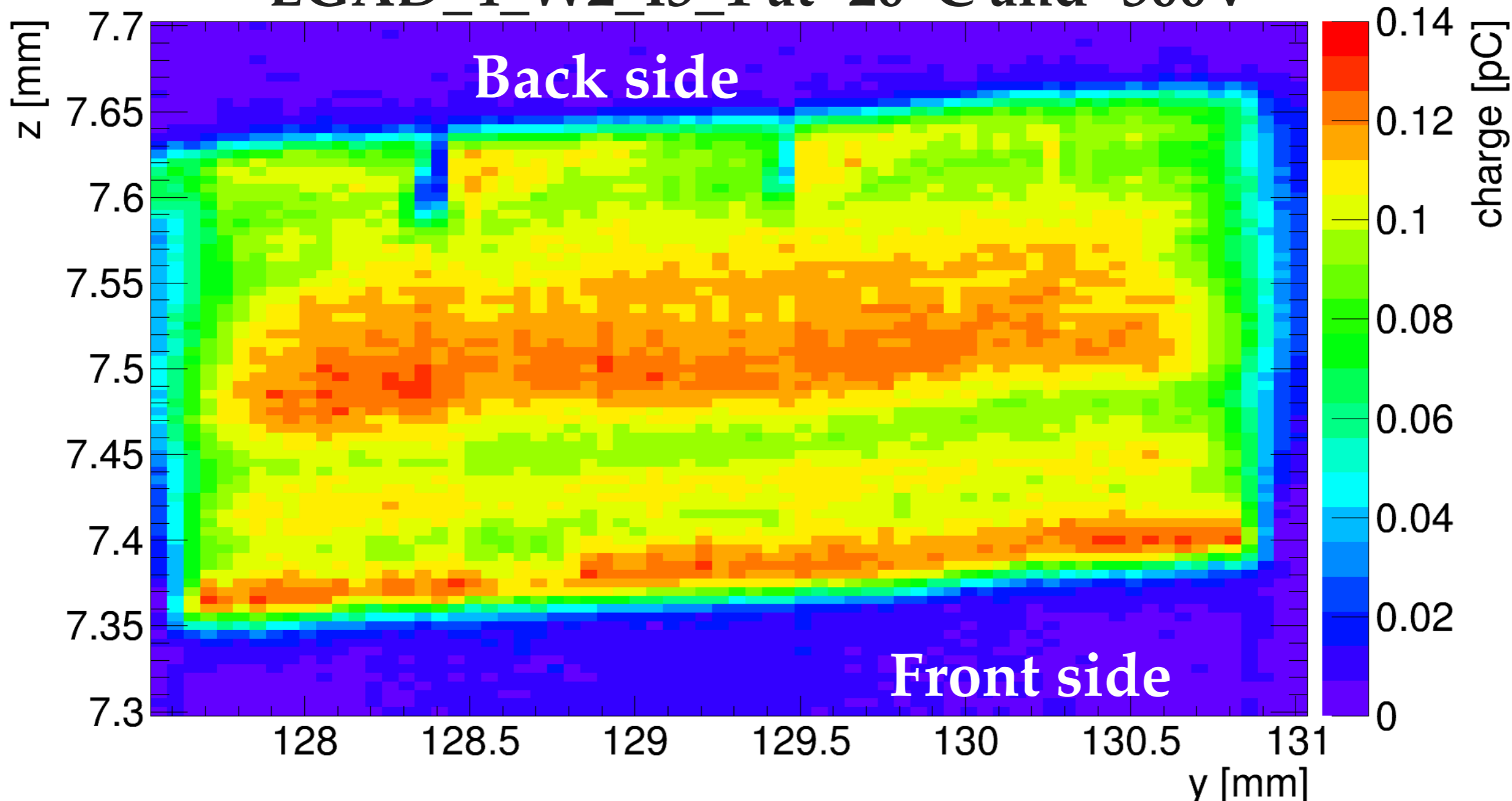
PRELIMINARY



Integrated charge in 0.6 ns [$Q(0.6 \text{ ns})$]

PRELIMINARY

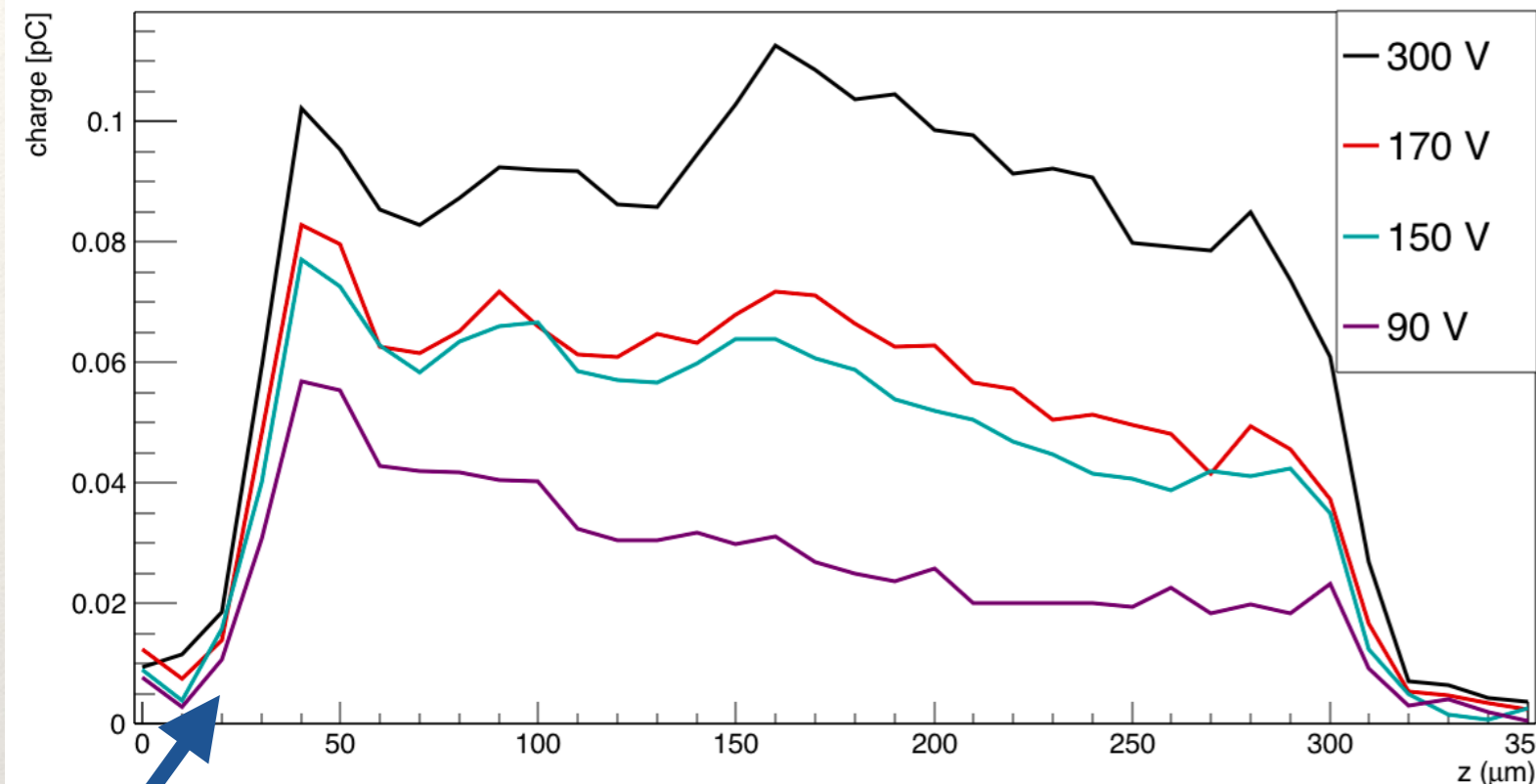
LGAD_4_W2_I3_1 at -20°C and -300V



Integrated charge in 0.6 ns [$Q(0.6 \text{ ns})$]

PRELIMINARY

eTCT - LGAD_4_W2_I3_1 - $1 \text{E}14 \text{ n}_{\text{eq}}/\text{cm}^2$ - Q(0.6ns) at 20°C

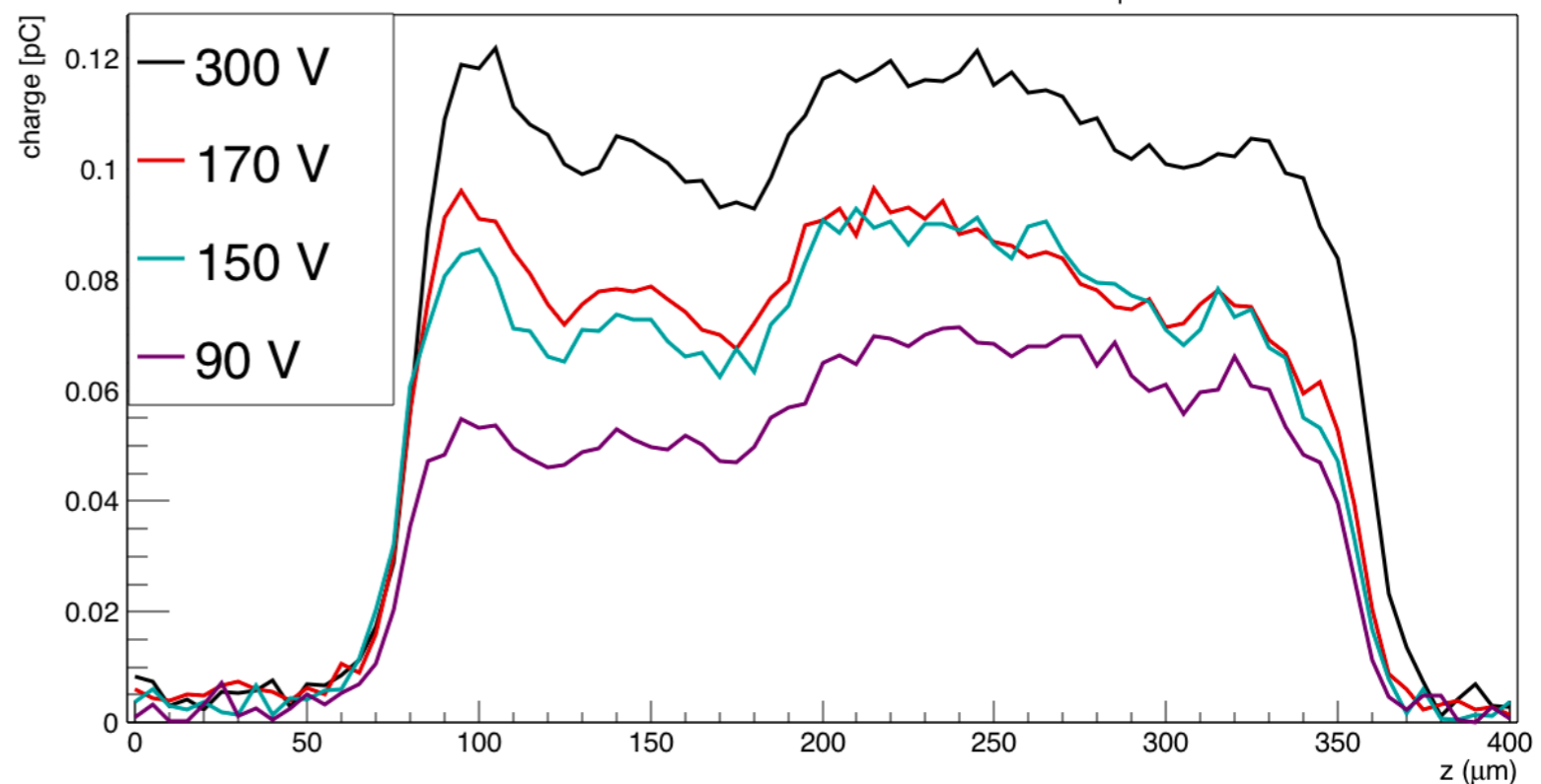


❖ 20°C : More charge collected close to the front electrode at low voltages.

Front side

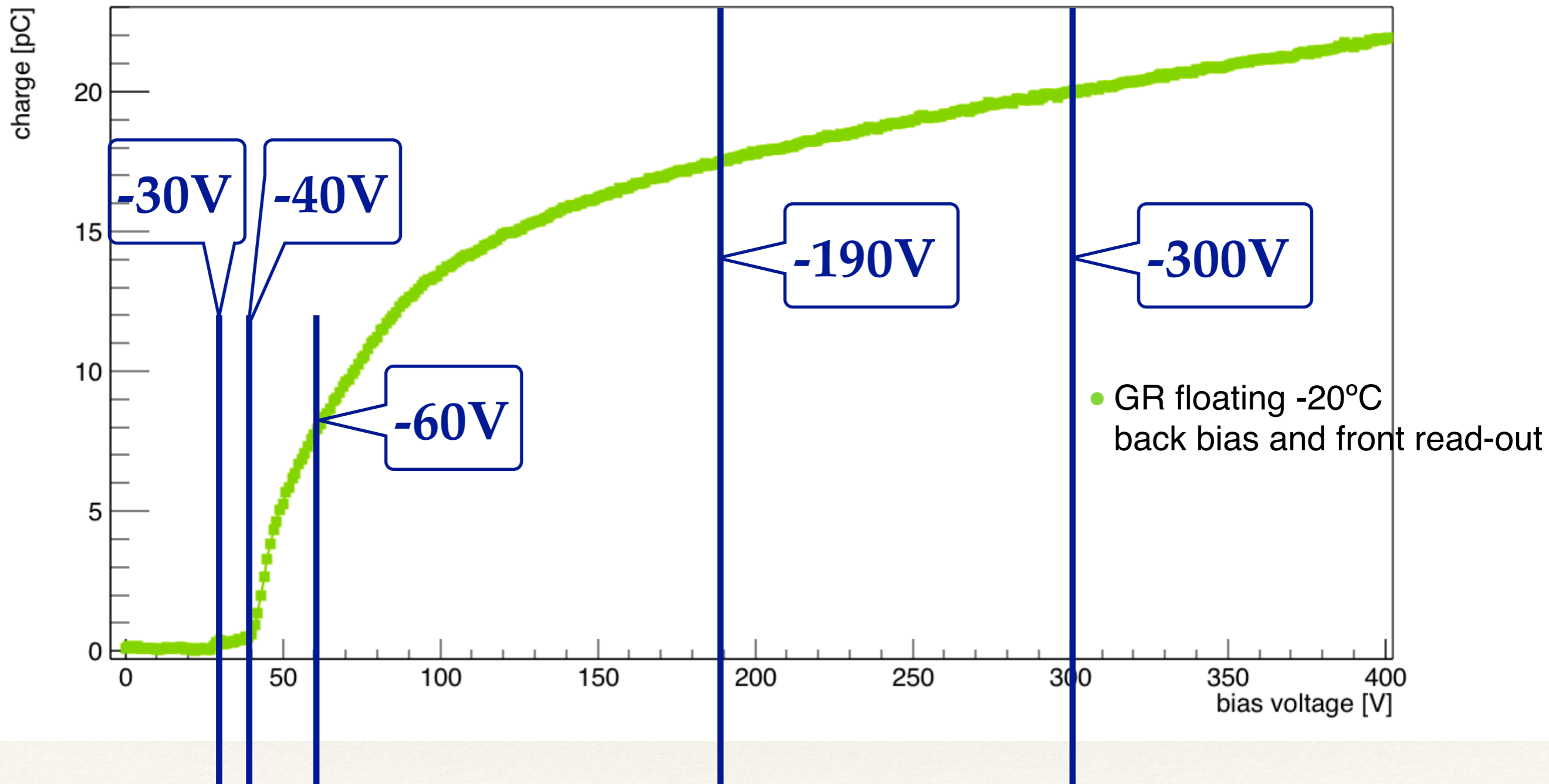
❖ -20°C : More charge collected close to the back electrode at low voltages.

eTCT - LGAD_4_W2_I3_1 - $1 \text{E}14 \text{ n}_{\text{eq}}/\text{cm}^2$ - Q(0.6ns) at -20°C



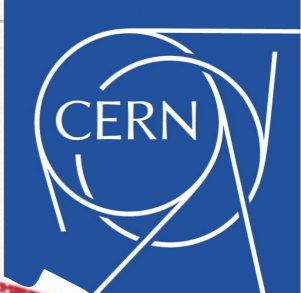
Voltages for eTCT

Red front TCT - LGAD_7859_7_W3_C2_3 - $1 \text{E}14 \text{ n}_{\text{eq}}/\text{cm}^2$



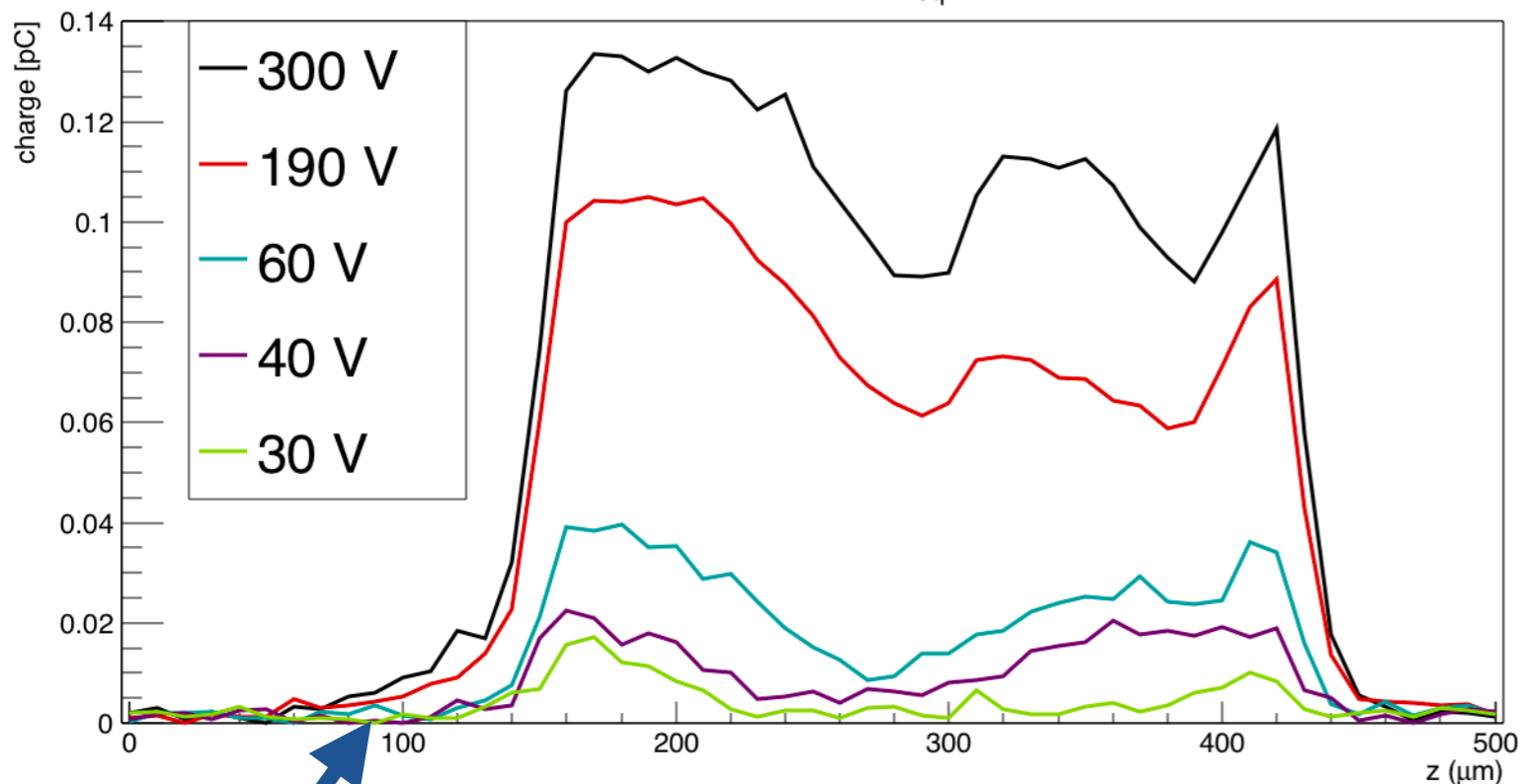


eTCT - Mult. Layer $2.0 \times 10^{13} \text{cm}^{-2}$



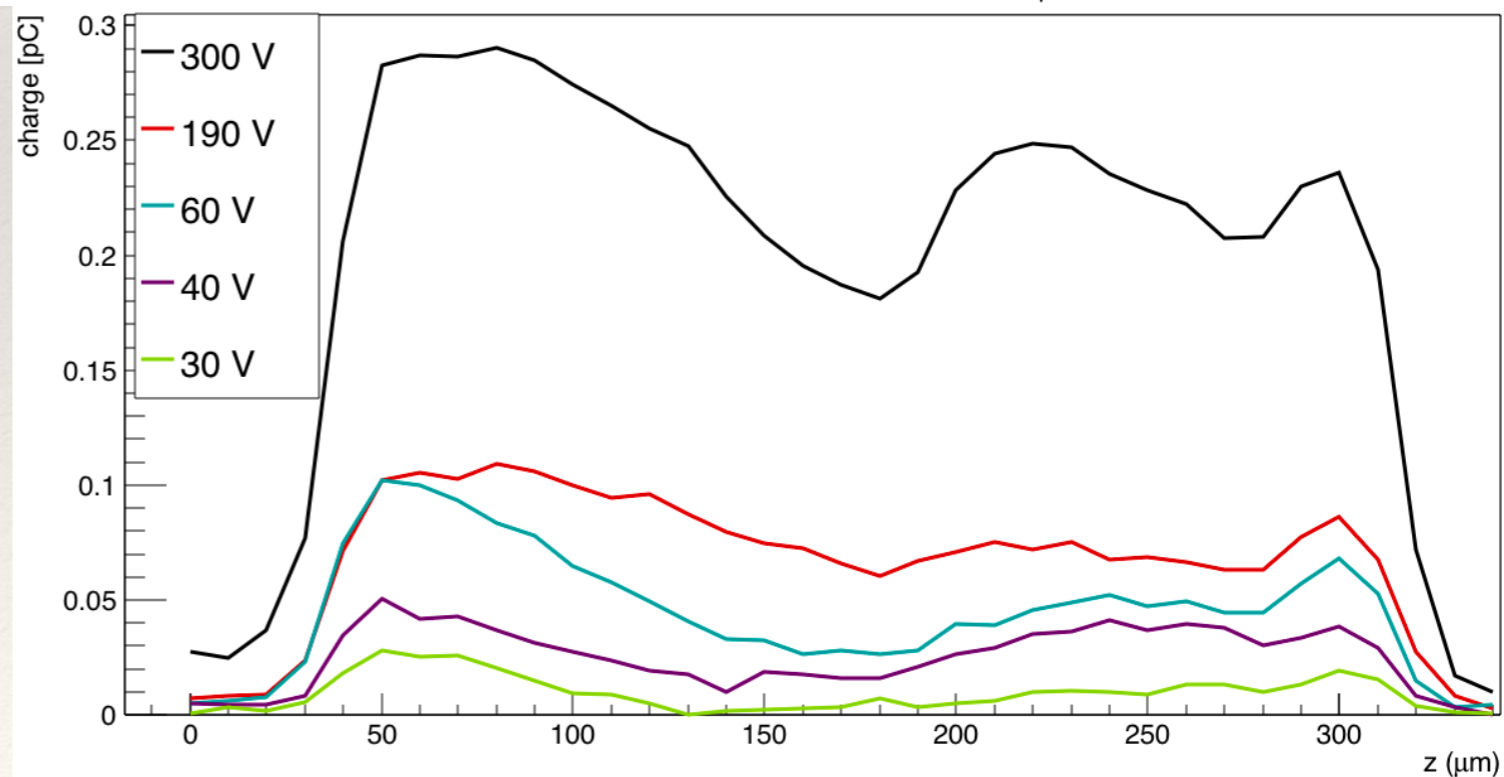
PRELIMINARY

eTCT - LGAD_7_W3_C2-3 - $1\text{E}14 \text{ n}_{\text{eq}}/\text{cm}^2$ - Q(0.6ns) at 20°C



❖ Temperature does not seem to affect the charge collection profile.

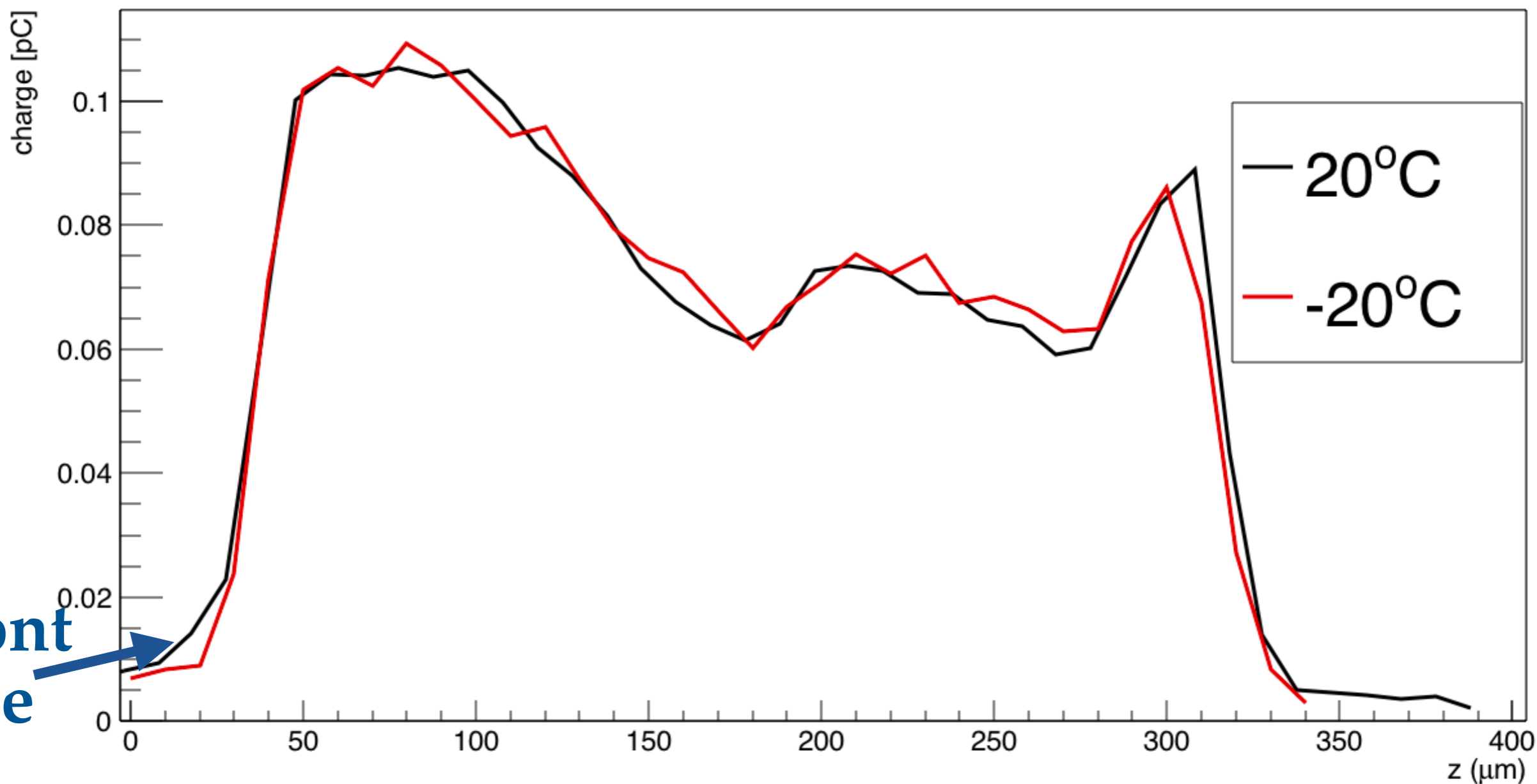
eTCT - LGAD_7_W3_C2-3 - $1\text{E}14 \text{ n}_{\text{eq}}/\text{cm}^2$ - Q(0.6ns) at -20°C



Front side

PRELIMINARY

eTCT - LGAD_7_W3_C2-3 - $1 \text{E}14 \text{ n}_{\text{eq}}/\text{cm}^2$ - Q(0.6ns) at -190 V



Front side

Conclusions

- ❖ LGAD_7859_4_W2_I3-1 - Multiplication layer dose: $1.8 \times 10^{13} \text{cm}^{-2}$.
 - ❖ Irradiated up to 10^{14} 1 MeV $n_{\text{eq}} / \text{cm}^2$.
 - ❖ Low leakage current device.
 - ❖ TCT voltage scans and eTCT seem to confirm the hypothesis of the double junction effect.
 - ❖ The electric field grows from the back of the device.
 - ❖ Open question: why is this effect present in low leakage current devices?
- ❖ LGAD_7859_7_W3_C2-3 - Multiplication layer dose: $2.0 \times 10^{13} \text{cm}^{-2}$.
 - ❖ Irradiated up to 10^{14} 1 MeV $n_{\text{eq}} / \text{cm}^2$.
 - ❖ Low leakage current device.
 - ❖ Same annealing history as sample LGAD_7859_4_W2_I3-1.
 - ❖ In 2016 it showed clear signs of double junction effect.
 - ❖ In 2017 the multiplication-onset voltage went down to an unirradiated-like value.

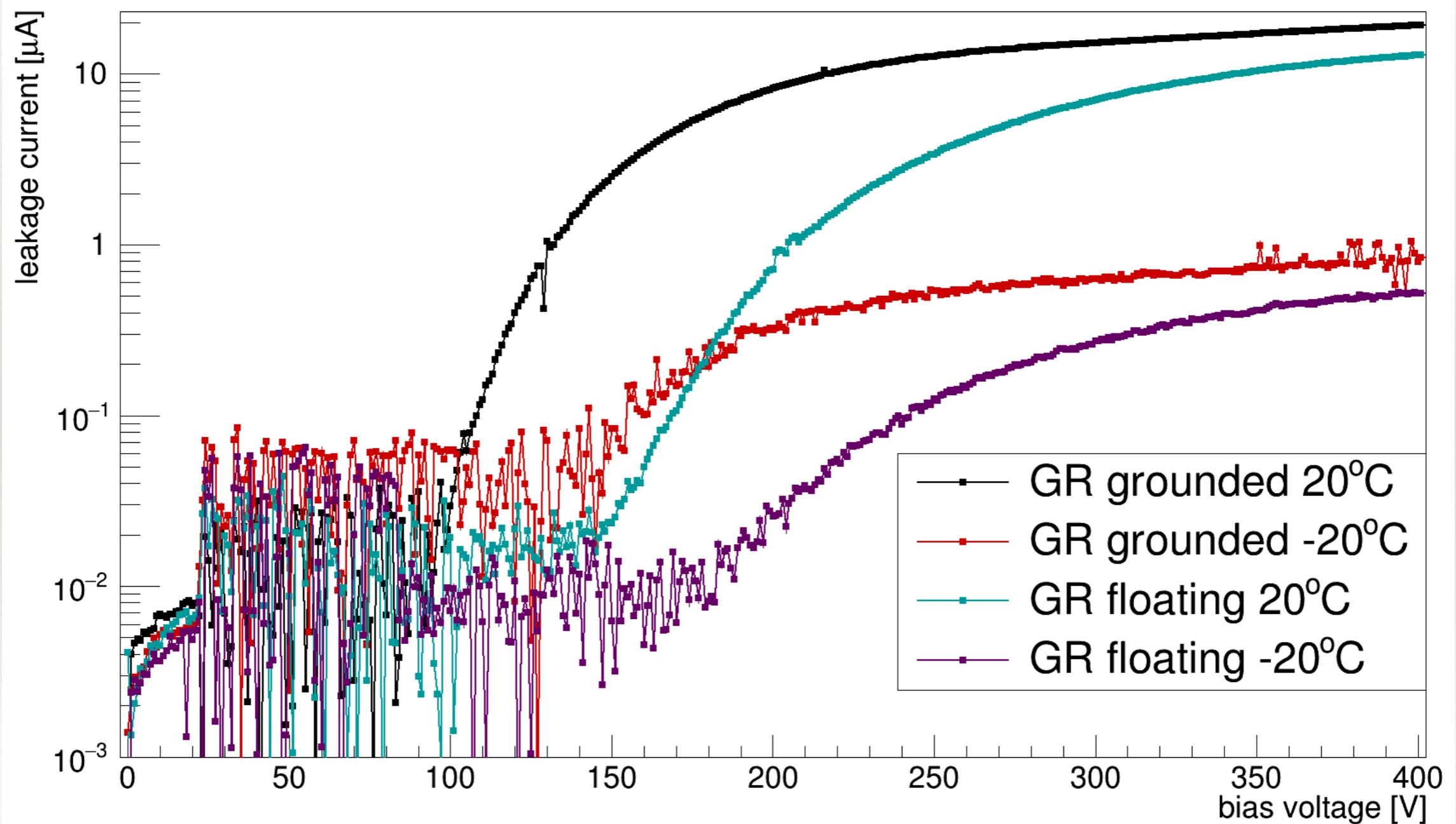
Further Studies

- ❖ Repeat the measurements on all the irradiated devices (fluences between 10^{12} and 10^{15} $1 \text{ MeV } n_{\text{eq}}/\text{cm}^2$).
 - ❖ With and without illumination by a LED.
- ❖ Perform a detailed temperature dependance study on the samples:
 - ❖ TCT voltage scans at several temperatures between 20°C and -20°C .
- ❖ Carry out new eTCT scans on the samples with a polished edge for better resolution.
 - ❖ eTCT scans at different voltages.
 - ❖ eTCT scans at several temperatures between 20°C and -20°C .
- ❖ Irradiate to 10^{14} $1 \text{ MeV } n_{\text{eq}}/\text{cm}^2$ the LGAD we had kept unirradiated for reference.
 - ❖ Perform the aforementioned analyses.
 - ❖ Do an annealing study on the device.

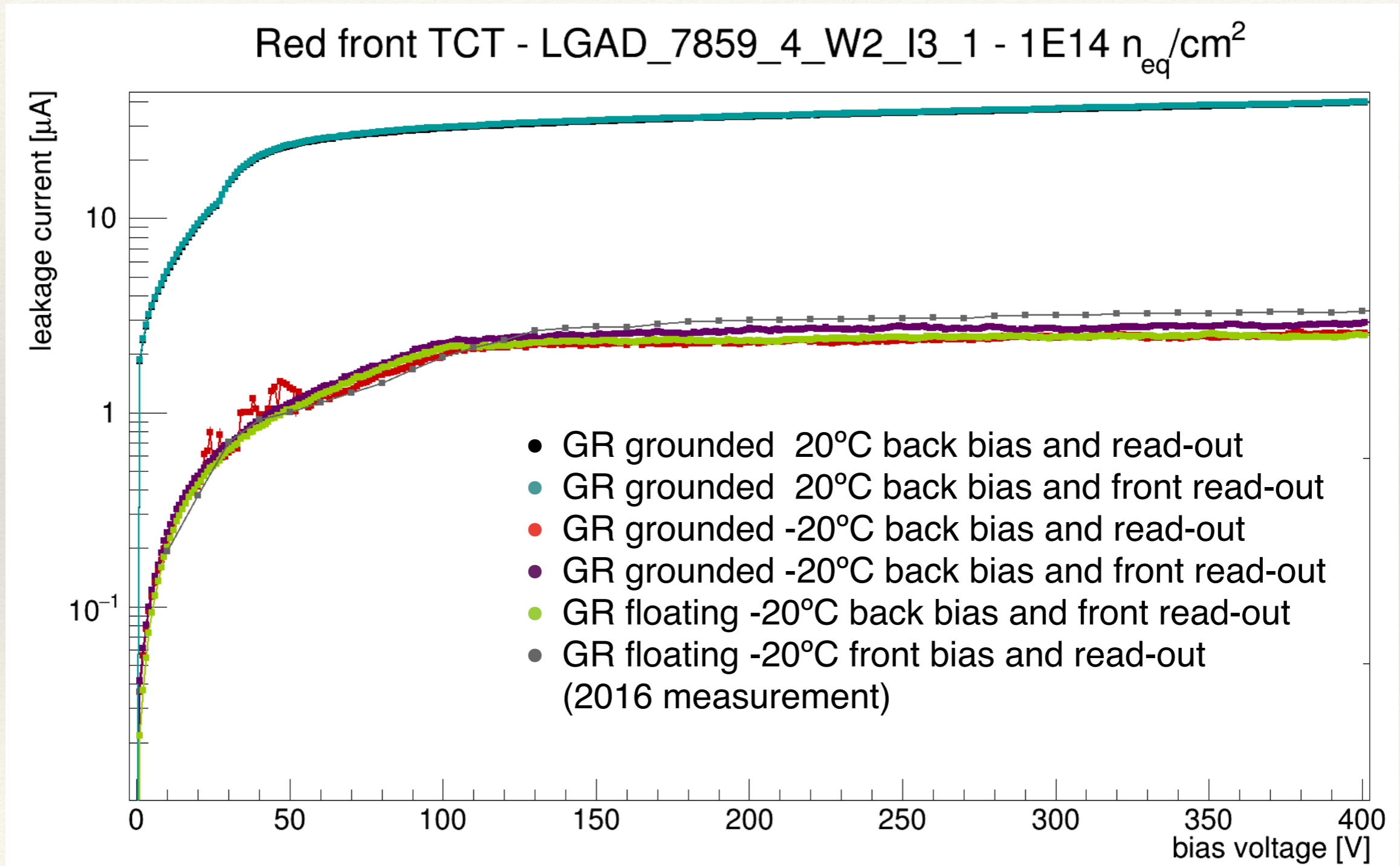
Backup Slides

- ❖ IV curves obtained during the Red Front TCT measurements.

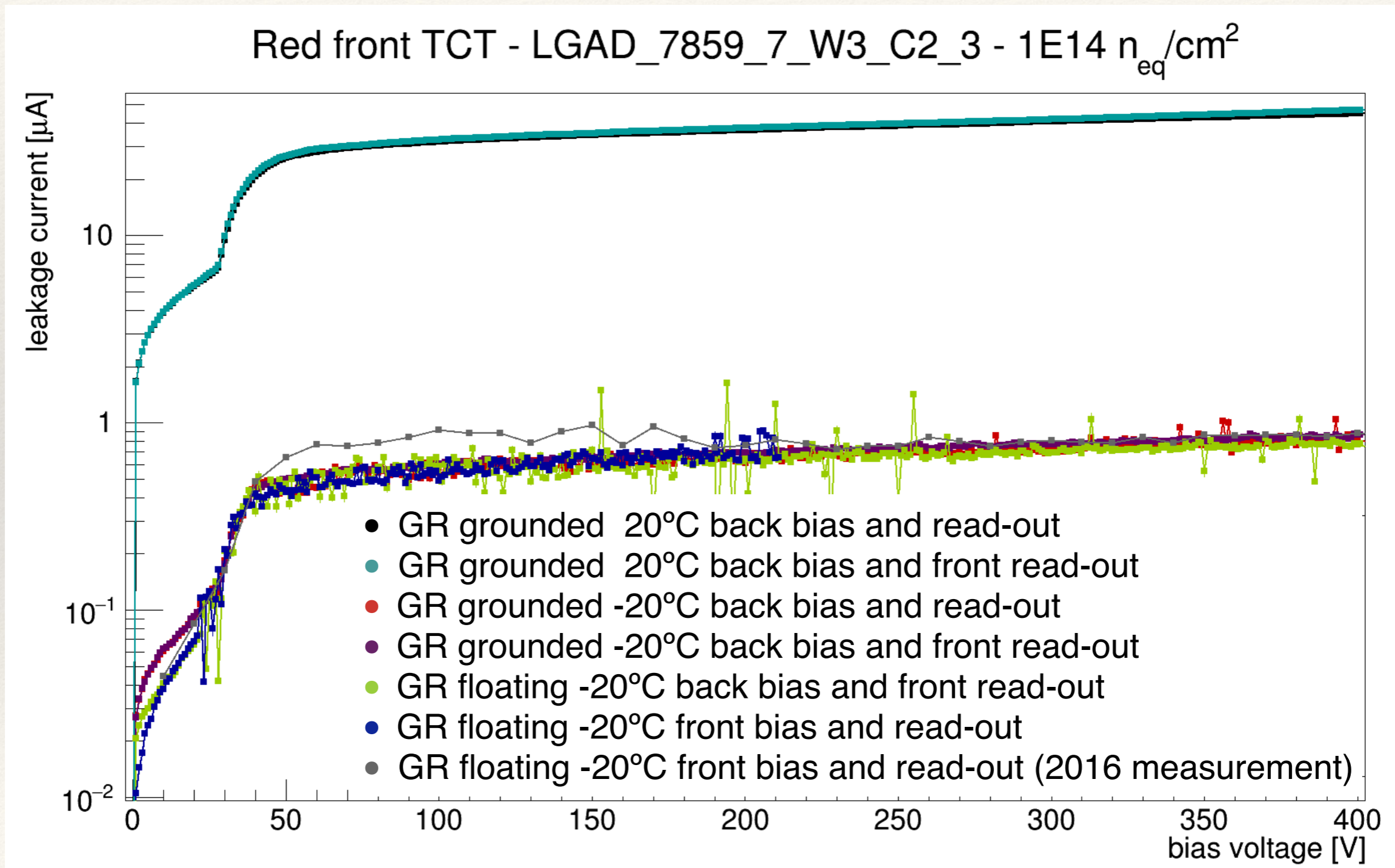
Red front TCT - LGAD_7859_W4_D7-1 - Unirradiated - back bias and read-out



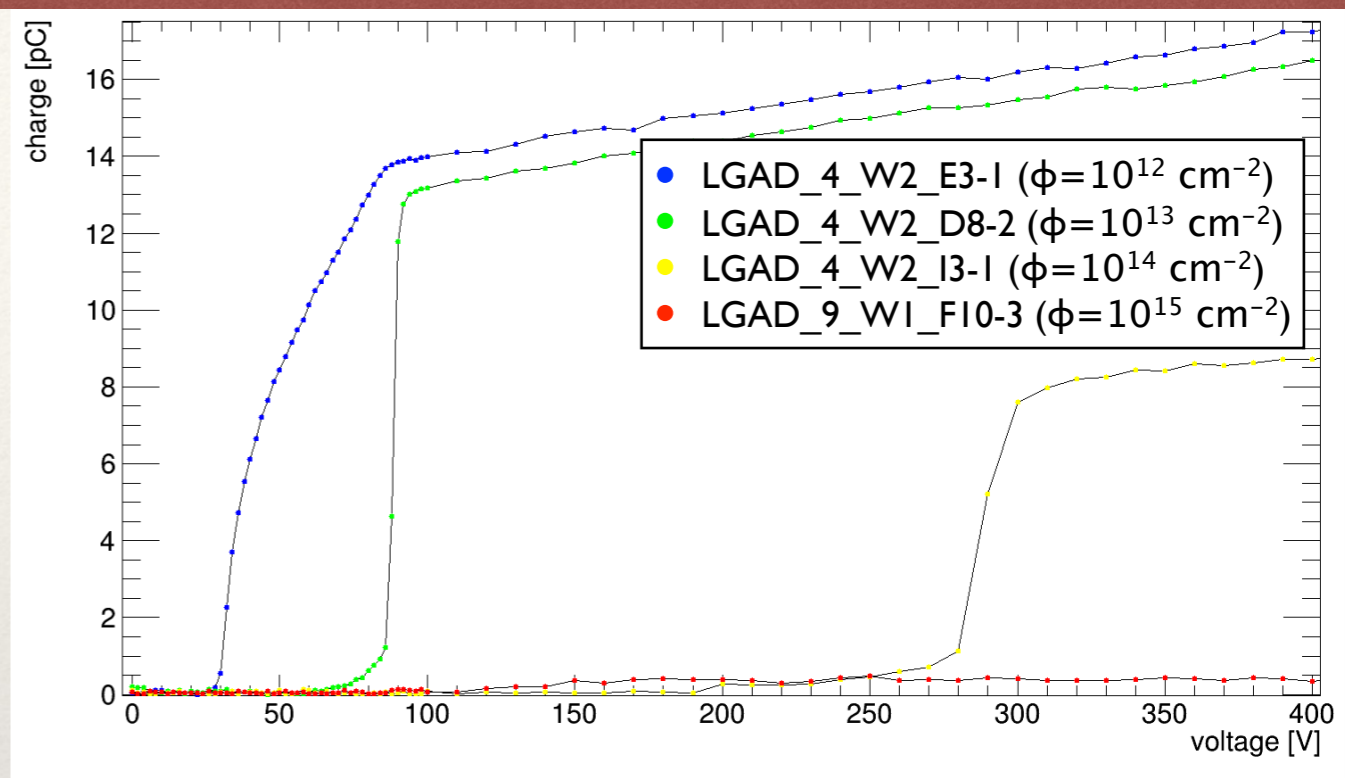
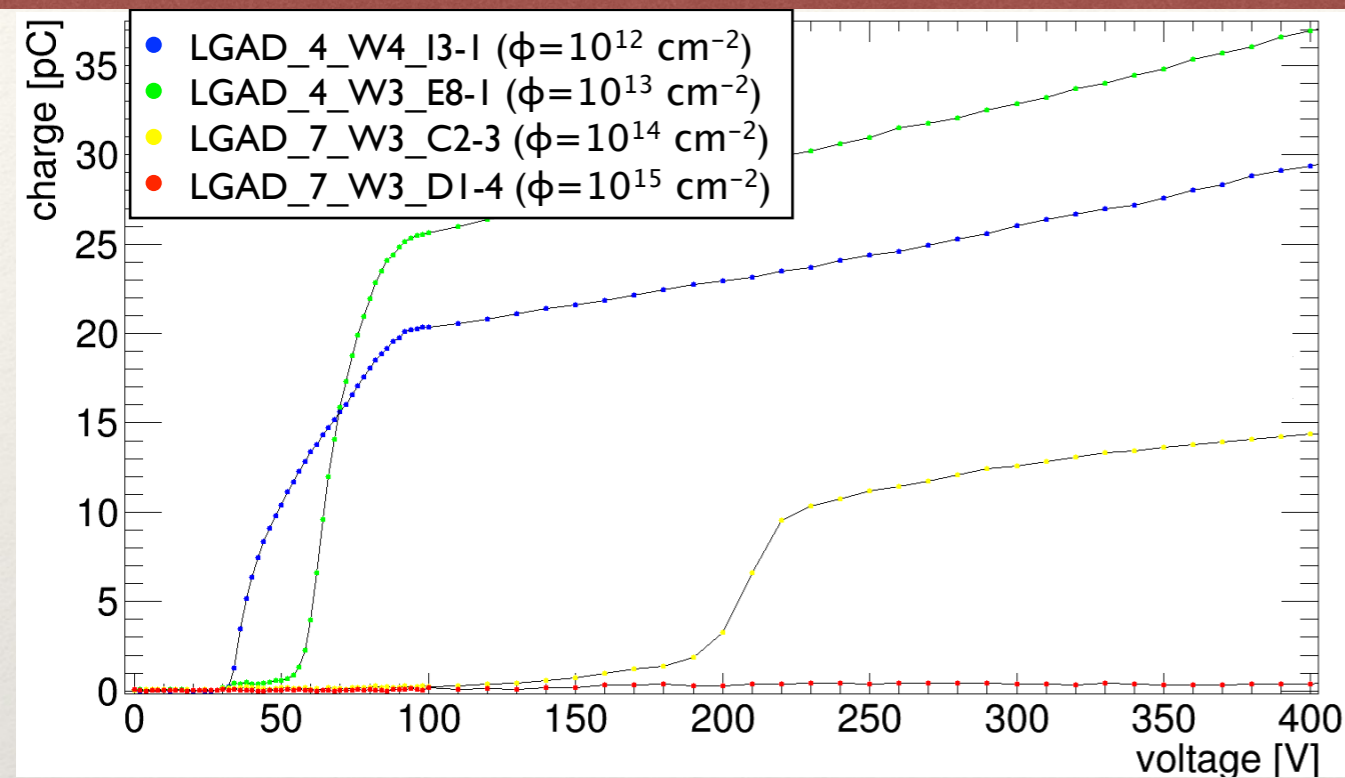
- ❖ IV curves obtained during the Red Front TCT measurements.



- ❖ IV curves obtained during the Red Front TCT measurements.



LGAD - TCT - Red front @ -20°C



- ❖ To actually have gain, the multiplication layer must be depleted.
- ❖ The threshold voltage indicates as from which voltage the multiplication layer is depleted.
- ❖ The threshold voltage can be determined by red front TCT.